

COMMON PARTS/MATERIALS, SPACE USE,  
APPLICATION DATA SHEET FOR

Part Description	CONNECTORS, RECTANGULAR, MINIATURE, HIGH DENSITY, HIGH RELIABILITY, SPACE USE
Part Number and Type	ND114-*P-** ND114-*S-** ND104-P-** ND104-S-**
Applicable Specification	JAXA-QTS-2060 JAXA-QTS-2060/D114A

August 2025

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Issued by Japan Aerospace Exploration Agency

This document is the English version of JAXA QTS/ADS which was originally written and authorized in Japanese and carefully translated into English for international users. If any question arises as to the context or detailed description, it is strongly recommended to verify against the latest official Japanese version.

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## Record of revisions

Rev.	Date	Description
NC	Jul. 2004	Original
A	8 Jun. 2009	Reflected the change of document by Japan Aviation Electronics Industry, Ltd. Document No: JAHL-3300 (Rev. A)
B	18 Jun. 2012	Reflected the change of document by Japan Aviation Electronics Industry, Ltd. Document No: JAHL-3300 (Rev. B)
C	2 Mar. 2015	Reflected the change of document by Japan Aviation Electronics Industry, Ltd. Document No: JAHL-3300 (Rev. C)
D	5 Apr. 2022	Reflected the change of document by Japan Aviation Electronics Industry, Ltd. Document No: JAHL-3300 (Rev. D)
E	25 Feb. 2025	Reflected the change of document by Japan Aviation Electronics Industry, Ltd. Document No: JAHL-3300 (Rev. 6 and 7)
F	21 Aug. 2025	Reflected the change of document by Japan Aviation Electronics Industry, Ltd. Document No: JAHL-3300 (Rev. 8)
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JAXA-ADS-2060/D114F 21 August 2025		J A X A Application Data Sheet	Page	– ii –
JAHL-3300				
Revision history				
Rev.	Date	Description		
NC	Jul. 2004	Original		
A	8 Jun. 2009	Revised in accordance with JAXA-QTS-2060C. <ul style="list-style-type: none"> <li>Changed “NASDA” to “JAXA”.</li> <li>Paragraph 1.2: Changed the title of MIL-STD-202. Added MIL-DTL-22520 instead of MIL-C-22520.</li> <li>Paragraph 2.2: Deleted the definition of “N” (Series) and added a Note: “N” indicates the part is for space use.</li> <li>Paragraph 5.10: Changed the measured values of outgassing due to the change of silicon resin used for the environmental protection. Corrected the TML value of silicon resin (grommet adhesion). Added the outgassing data for the finished product.</li> <li>Paragraph 7.1: Corrected the mass of crimp connectors to include contacts.</li> <li>Paragraph 7.4: Changed the address and telephone number of the contact.</li> </ul>		
B	18 Jun. 2012	Revised in association with the addition of insulator materials. <ul style="list-style-type: none"> <li>Paragraph 5.5.1: Added test data to Dielectric Withstanding Voltage (Life)</li> <li>Paragraph 5.5.2: Added test data to Dielectric Withstanding Voltage (Altitude)</li> <li>Paragraph 5.7: Reflect the test results of Shock test conducted for re-qualification.</li> <li>Paragraph 5.10: Added the outgas data of the insulator material, AM113J (Black)</li> </ul>		
C	2 Mar. 2015	Revised in association with the addition of curing agent for epoxy adhesive. <ul style="list-style-type: none"> <li>Paragraph 5.5.1: Added test data to Dielectric Withstanding Voltage (Life)</li> <li>Paragraph 5.5.2: Added test data to Dielectric Withstanding Voltage (Altitude)</li> <li>Paragraph 5.10: Added tables for Outgassing data and Results of Outgas Mass Distribution Calculation for epoxy adhesive with “15-1 CLEARJ” curing agent.</li> <li>Paragraph 7.4: Changed the contact information due to organization change. Changed Information and industrial devices sales group of Connector 2nd Sales Div. to Connector 2nd Sales Div.</li> </ul>		
D	5 Apr. 2022	Revised in association with the addition of epoxy adhesive. <ul style="list-style-type: none"> <li>Paragraph 2.3: Added the arrow to the connector external figures (Figs. 2 to 5) indicating “Press pin adhesive and potting” for epoxy adhesive application.</li> <li>Paragraph 5.5.1: Added test data for Dielectric Withstanding Voltage (Life)</li> <li>Paragraph 5.5.2: Added test data for Dielectric Withstanding Voltage (Altitude)</li> <li>Paragraph 5.10: Added table for outgas data and Results of Outgas Mass Distribution Calculation for epoxy adhesives (TB2234H).</li> </ul> Revised in association with the correcting errors in curing agent; 15-1 CLEARJ <ul style="list-style-type: none"> <li>Paragraph 5.10: Changed the mass of F insulator of ND114-104S-CR and ND114-104S-AB(1).</li> <li>Material mass: <math>1.321 \pm 0.008 \rightarrow 5.001 \pm 0.023</math></li> </ul>		

JAXA-ADS-2060/D114F 21 August 2025		J A X A Application Data Sheet	Page	– iii –
JAHL-3300				
Rev.	Date	Description		
		<ul style="list-style-type: none"> <li>TML: <math>0.00711 \pm 0.00011 \rightarrow 0.02691 \pm 0.00037</math></li> <li>CVCM: <math>0.00020 \pm 0.00001 \rightarrow 0.00075 \pm 0.00005</math></li> </ul>		
6	10 Feb. 2025	<p>Revision due to change in flame retardant in insulator.</p> <ul style="list-style-type: none"> <li>Paragraphs 1.2, 4.7, and 5 Changed from MIL-STD-1344 to EIA-364 due to the cancellation of MIL STD-1344</li> <li>Paragraph 5.5.1 Added test data for dielectric withstanding voltage (life.)</li> <li>Paragraph 5.5.2 Added test data for dielectric withstanding voltage (altitude.)</li> <li>Paragraph 5.10 Added table of outgassing data and outgassing mass distribution calculation results for insulator material (AM113J black BS).</li> <li>Paragraph 7.4 Revised contact information</li> </ul>		
7	25 Feb. 2025	<p>Corrected errors</p> <ul style="list-style-type: none"> <li>Paragraph 5.5.2 Changed the title of Figure 21-5 referred to the body.</li> <li>Paragraph 5.10 Revised nominal values and tolerances of material mass of F insulator and R insulator due to change the flame retardant containing of those insulators in Table 11-2. Revised TML and CVCM values recalculated with the measurement results from the changes of the flame retardant. (Changed values are indicated in red.)</li> </ul>		
8	21 Aug. 2025	<p>Page 15 Added "Unit: mm" on Table 7. Page 16 Added "Unit: mm" on Figure 16. Revised in association with addition of Epoxy adhesive.</p> <ul style="list-style-type: none"> <li>Paragraph 5.5.1 Added test data to Dielectric Withstanding Voltage (Life).</li> <li>Paragraph 5.5.2 Added test data to Dielectric Withstanding Voltage (Altitude).</li> <li>Paragraph 5.10 Added tables of outgassing data and outgassing mass distribution calculation results for epoxy adhesive (TB2270C).</li> </ul> <p>Page 40 Added "Insulator: black B/" in parentheses in the item name column of each table. Page 41 Added "insulator: black BS/press pin adhesive and potting material: TB2270C" in the item name column of each table. Page 42 Paragraph 5.12 (1) Changed from MIL-H-5606 to MIL-PRF-5606. Page 42 Paragraph 5.12 (2) Changed MIL-L-23699 to MIL-PRF-23699. Changed the revision date of the Revision history from Japanese era to Western calendar (Changes only applicable in Japanese.)</p>		

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– iv –
			JABL-3300
<b>Contents</b>			
1.	GENERAL .....	1	
1.1	Scope.....	1	
1.2	Applicable Documents.....	1	
2.	SUMMARY OF PRODUCTS.....	2	
2.1	Outline.....	2	
2.2	Part Number.....	3	
2.3	Externals of Connectors .....	5	
2.4	Contact Arrangement .....	7	
2.5	Connection Options.....	7	
2.6	Interchangeability of Connectors .....	7	
2.7	Applicable Wire Sizes.....	7	
3.	USAGE .....	7	
3.1	Tools for Wiring and Assembly.....	7	
3.2	Wiring and Assembly Methods .....	8	
3.2.1	Stripping Wire Jacket .....	9	
3.2.2	Contact Crimping .....	9	
3.2.3	Contact Installation.....	13	
3.2.4	Contact Replacement.....	14	
3.2.5	Soldering.....	14	
3.3	Dimensions for Mounting Holes.....	15	
3.3.1	Crimp and Soldering Type Connectors.....	15	
3.3.2	Right Angle Through Hole Type Connectors .....	16	
3.4	Precautions .....	17	
3.4.1	Wiring.....	17	
3.4.2	Assembly .....	17	
3.4.3	Electrical Conductivity Check .....	17	
3.4.4	Mating and Unmating .....	17	
4.	CHARACTERISTICS UNDER NORMAL OPERATING CONDITIONS .....	18	
4.1	Ratings.....	18	
4.2	Electrical Characterisitcs .....	18	
4.3	Mechanical Characteristics.....	18	
4.4	Thermal Characteristics .....	18	
4.5	Current Capacity .....	19	
4.6	Temperature Rise .....	19	
4.7	Breakdown Voltage .....	21	
5.	CHARACTERISTICS UNDER VARIOUS OPERATING CONDITIONS AND ENVIRONMENTAL LIMITS.....	21	
5.1	Salt Spray .....	21	
5.2	Sulfidation .....	22	
5.3	Humidity.....	22	
5.4	Thermal characteristics .....	23	
5.4.1	Temperature Cycling.....	23	
5.4.2	Temperature Life.....	24	
5.4.3	Thermal Vacuum.....	24	

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– v –
			JABL-3300
5.5	Dielectric Withstanding Voltage .....	24	
5.5.1	Dielectric Withstanding Voltage (Life) .....	25	
5.5.2	Dielectric Withstanding Voltage (Altitude) .....	28	
5.6	Vibration .....	32	
5.6.1	High Frequency Vibration .....	32	
5.6.2	Random Vibration .....	32	
5.7	Shock .....	33	
5.8	Operating Life .....	33	
5.9	Creep at Crimped Area .....	33	
5.10	Outgassing .....	34	
5.11	Residual Magnetization .....	41	
5.12	Fluid Immersion .....	41	
5.13	Resistance to Solvent .....	41	
5.14	Radiation Hardness .....	41	
6.	STORAGE CONDITIONS .....	41	
7.	OTHERS .....	42	
7.1	Mass .....	42	
7.2	Accessories .....	42	
7.3	Cables .....	42	
7.4	Contact Information .....	43	

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 1 –
JAHL-3300			
<b>COMMON PARTS/MATERIALS, SPACE USE, APPLICATION DATA SHEET FOR</b>			
1. GENERAL			
1.1 Scope			
This Application Data Sheet details additional general information necessary for parts selection and/or equipment design that is not contained in JAXA-QML. Users are encouraged to look into other information sources for specific applications, and responsible for their decisions on part selection and usage.			
1.2 Applicable Documents			
JAXA-QTS-2060F	Connectors, High Reliability, Space Use, General Specification for		
JAXA-QTS-2060/D114A	Connectors, Rectangular, Miniature, High Density, High Reliability, Space Use, Detail Specification For		
EIA-364	Test Methods for Electrical Connectors.		
MIL-STD-202	Test Method Standard Electronic and Electrical Component Parts		
MIL-DTL-22520	Crimping Tools, Wire Termination, General Specification for		



## 2. SUMMARY OF PRODUCTS

### 2.1 Outline

Connectors described in this data sheet are high reliability parts for electronic equipment to be installed on satellites and/or launch vehicles. The connectors are rectangular high density miniature connectors which are generally referred to as D-sub connectors.

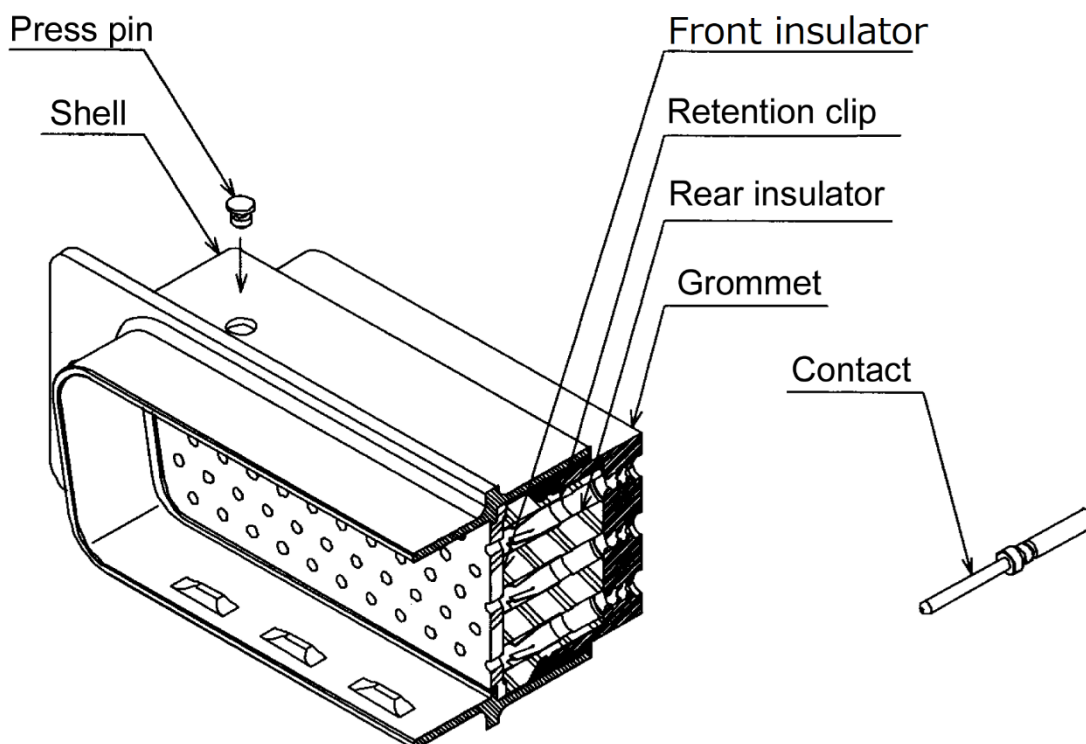
Considering the space environments such as magnetism, outgassing and sublimation, nonferrous materials and gold plated surface finishes are used.

Shells are rectangular in shape and the mating opening is of D-shape to prevent mis-mating. The number of contacts is 104.

Insulators with metal contact retention clips enable easy contact insertion and removal by the rear-release method.

Contacts are gold plated over copper alloy which has good electrical conductivity, and the contact size is 22. Pin contacts are of round type, and socket contacts have a closed-entry design for high reliability contact mechanism. There are two styles of termination for contacts; i.e., crimp and right angle through hole.

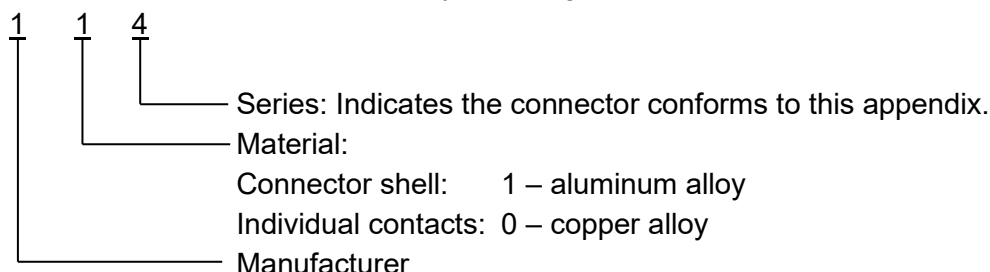
The connectors are interchangeable with JAXA- or MIL-certified rectangular connectors.



**Figure 1. Connector-Cross Section View (Crimp Pin Connector)**

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 3 –
J AHL-3300			
2.2	Part Number		
The part numbers of these connectors are assigned as follows.			
[Connectors]			
N <sup>(1)</sup> <u>D</u> <u>114</u> – <u>104</u> <u>P</u> – <u>C</u> <u>L</u> <u>R</u> <u>(1)</u>			
			(8) Length of termination
			(7) Grommet and location plate
			(6) Inclusion of contacts
			(5) Termination style
			(4) Contact type
			(3) Contact arrangement
			(2) Identification number
			(1) Connector type
[Individual Contacts]			
N <sup>(1)</sup> <u>D</u> <u>104</u> – <u>P</u> – <u>C</u> <u>22D</u>			
			(7) Contact category
			(5) Termination style
			(4) Contact type
			(2) Identification number
			(1) Connector type
Note: <sup>(1)</sup> “N” indicates the part is for space use.			

- (1) Connector type: Identified by a single capital letter. “D” indicates a “D-sub connector.”
- (2) Identification number: Identified by three digits as follows.



- (3) Contact arrangement: Shell size is identified by a capital letter. Contact arrangement is identified by a two- or three-digit number which indicates the number of contacts (See Figure 6).
- (4) Contact type: Identified by a single letter, “P” or “S”, which indicates a pin contact (male) or socket contact (female), respectively.
- (5) Termination style: Identified by a single letter as shown in Table 1.

**Table 1. Termination Style**

Symbol	Termination style
C	Crimp
A	Right angle through hole

- (6) Inclusion of contacts: Blank denotes that the connector includes contacts. “L” denotes that the connector does not include any contact. For a crimp-contact connector, the connector includes type “22D” contacts.
- (7) Contact category: Applicable only to crimp termination type. “22D” denotes crimp contact of size 22D.
- (8) Grommet and location plate: “R” denotes that the connector has a rear grommet. Blank denotes that the connector has no grommet. “B” denotes that the connector of right angle through hole type has no location plate, and blank denotes that the connector has a location plate
- (9) Length of right angle through hole: If the length between the tip of through hole and the connector flange surface is not  $5^{+0.8}_{-0.5}$  mm, it may be specified in parentheses at the end of the part number. For example, size  $1^{+0.8}_{-0.5}$  shall be indicated as ND\*14-104S-A(1) as shown in Figures 4 and 5.

## 2.3 Externals of Connectors

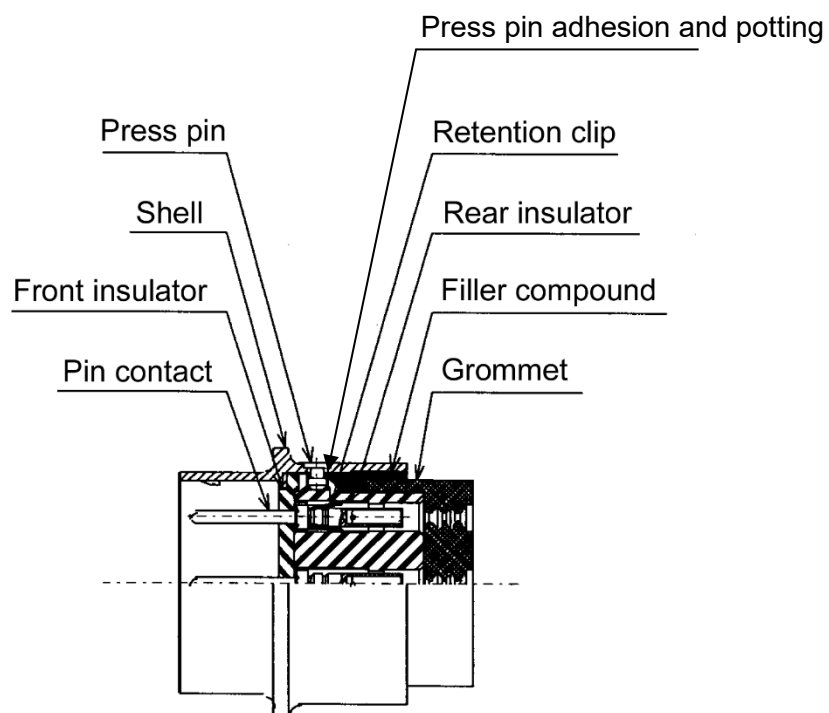


Figure 2. ND114-\*P-CR

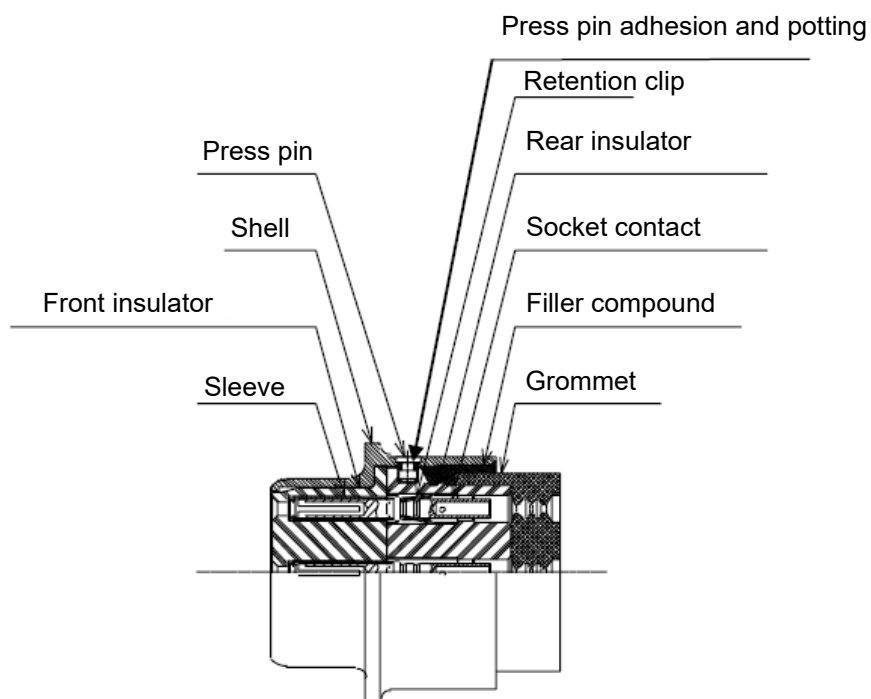


Figure 3. ND114-\*S-CR

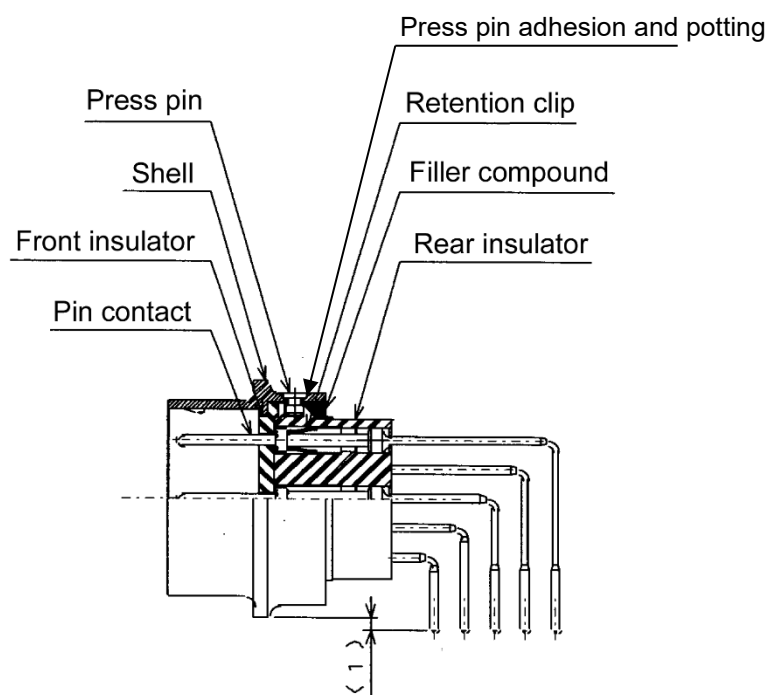


Figure 4. ND114-\*P-AB(1)

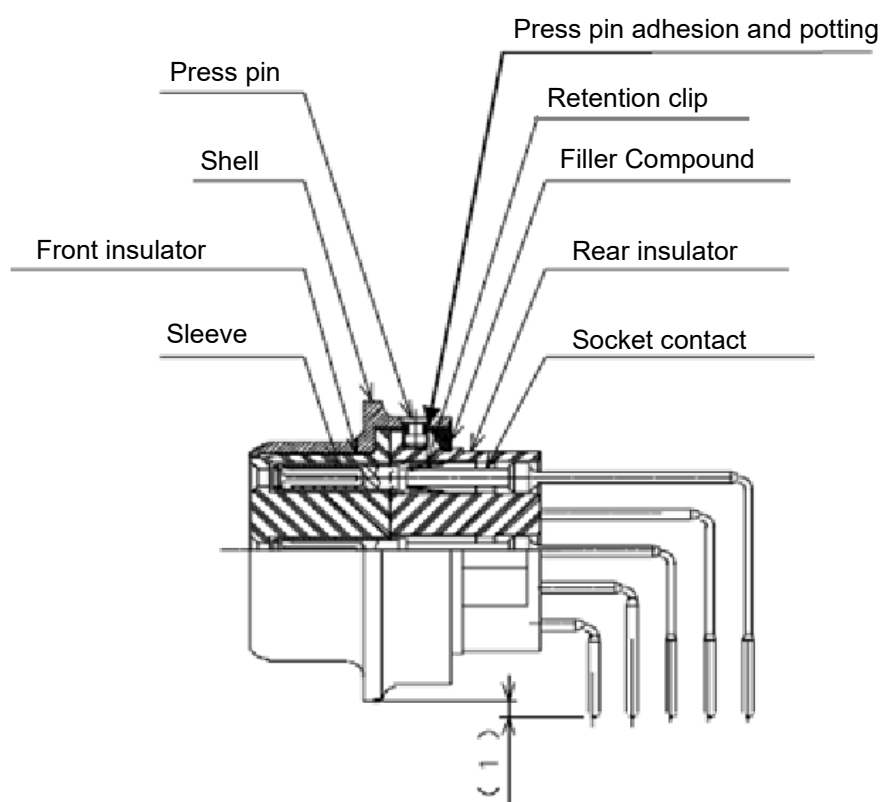


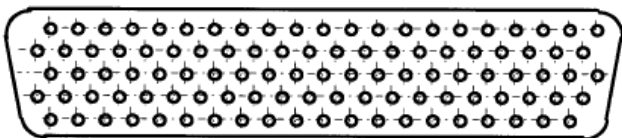
Figure 5. ND114-\*S-AB(1)

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 7 –
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J AHL-3300

2.4 Contact Arrangement

The contact arrangement is shown in Figure 6.



104 contacts (pin)

Figure 6. Contact Arrangement

Note: The figure above is the engaging face of the pin connector. The engaging face of the socket connector is a mirror image of the above figure.

2.5 Connection Options

The following connections are possible

Between panel and rack

Between panel and cable

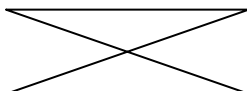
Between cable and cable

Between cable and PWB

Between PWB and PWB

2.6 Interchangeability of Connectors

Pin connectors and socket connectors of the same number of pins and sockets are intermatable in any combination.

[Pin connector]		[Socket connector]
Crimp type		Crimp type
Right angle through hole type		Right angle through hole type

2.7 Applicable Wire Sizes

Applicable wire sizes to crimp contacts are AWG 22 through 28.

For right angle through hole contacts, the through hole diameter shall be selected to allow  $\Phi 0.6\text{mm}$  for contact soldering,.

3. USAGE

3.1 Tools for Wiring and Assembly

In addition to general tools such as wire strippers and soldering irons, the following tools are required (Table 2).

**Table 2. Tools Required for Wiring and Assembly**

Tool	Connector	Crimp type
Crimping tool		M22520/2-01
Locator		M22520-2-09 (for pin), M22520-2-06 (for socket)
Inspection gauge for crimping tool		M22520/3-01
Contact insertion tool		CIET-22D (plastic) or MS27495A22M (metal)
Contact removal tool		CIET-22D (plastic) or MS27495R22M (metal)

### 3.2 Wiring and Assembly Methods

Wiring and assembly shall be performed in accordance with the processes shown in Table 3. Each process is detailed in paragraph shown in the “Paragraph no.” column.

**Table 3. Processes for Wiring and Engagement**

Paragraph no.	Process	Connector type	
		Crimp	Right angle through hole
3.2.1	Stripping wire jacket	O	
3.2.2	Contact crimping	O	
	(1) Inspection of crimping tool	O	
	(2) Crimping tool setting	O	
	(3) Contact insertion	O	
	(4) Wire insertion	O	
	(5) Crimping	O	
	(6) Contact extract	O	
	(7) Inspection of crimped contacts	O	
3.2.3	Contact installation	O	
	(1) Preparing insertion tool	O	
	(2) Insertion tool setting	O	
	(3) Contact insertion	O	
	(4) Contact retention check	O	
	(5) Inspection of installed condition	O	
3.2.4	Contact replacement	Δ	
	(1) Preparing removal tool	Δ	
	(2) Removal tool setting	Δ	
	(3) Contact extraction	Δ	
3.2.5	Soldering		O
	(1) Right angle through hole		O

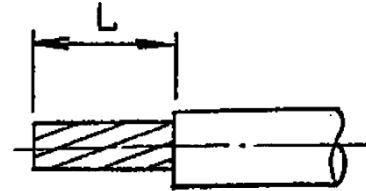
Note: “O” marking denotes “mandatory” processes and “Δ” denotes “non-mandatory” processes.

### 3.2.1 Stripping Wire Jacket

Strip the jacket at the termination side end by the length shown in Table 4.

**Table 4. Stripping Length of Wire Jacket**

Contact type	Length (L) (mm)
Crimp	4.1 <sup>0</sup> <sub>-0.5</sub>



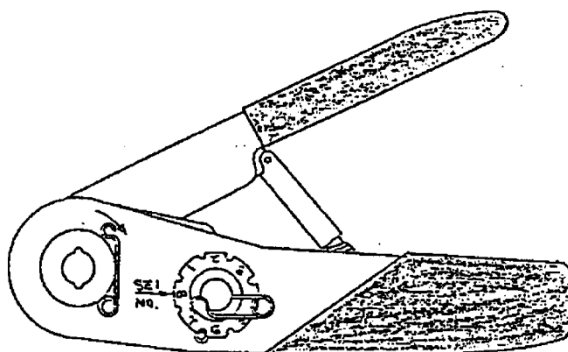
#### Notes:

- (1) “L” length is a recommended dimension. Use an appropriate length according to wire type and wire insertion condition (Figure 11).
- (2) Ensure not to damage or lose the individual wires while stripping. Keep the stranded wires from loosening.
- (3) For jackets which are difficult to remove, part of the jackets may stick to the conductor. Remove any jacket fragments from the conductor.
- (4) Perform crimping or soldering immediately after removal of the jacket before the conductor surface is oxidized.

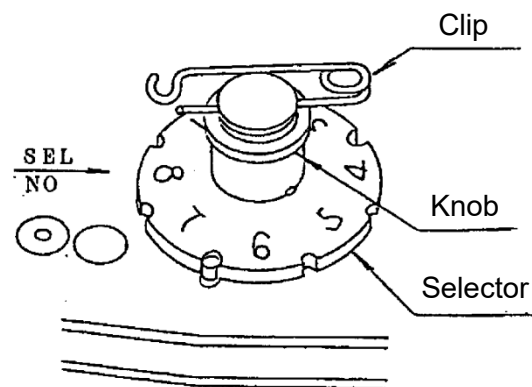
### 3.2.2 Contact Crimping

Wires shall be crimped to the contacts in accordance with following procedures.

- (1) Inspection of crimping tool
  - (a) Set the selector number of the crimping tool of M22520/2-01 (See Figure 7) to “8” and tighten the handle fully. To set the selector number, remove the clip, and pull up and rotate the knob.



(Crimping tool)

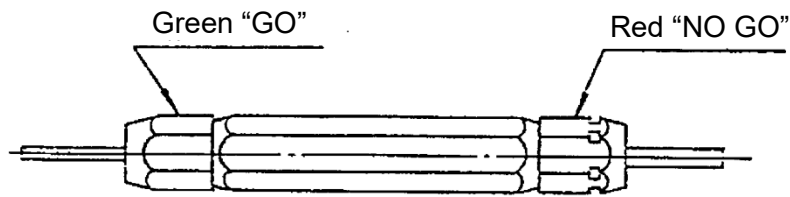


(Enlarged view of the selector)

**Figure 7. Crimping Tool**

- (b) While the handle is being tightened, check the gap of jaw (virtual diameter) using the inspection pin gauge of M22520/3-01 (See Figure 8). Verify “GO” side pin (green) passes the gap and “NO GO” side pin (red) does not. Perform this inspection every time before performing crimping to ensure proper crimping results.



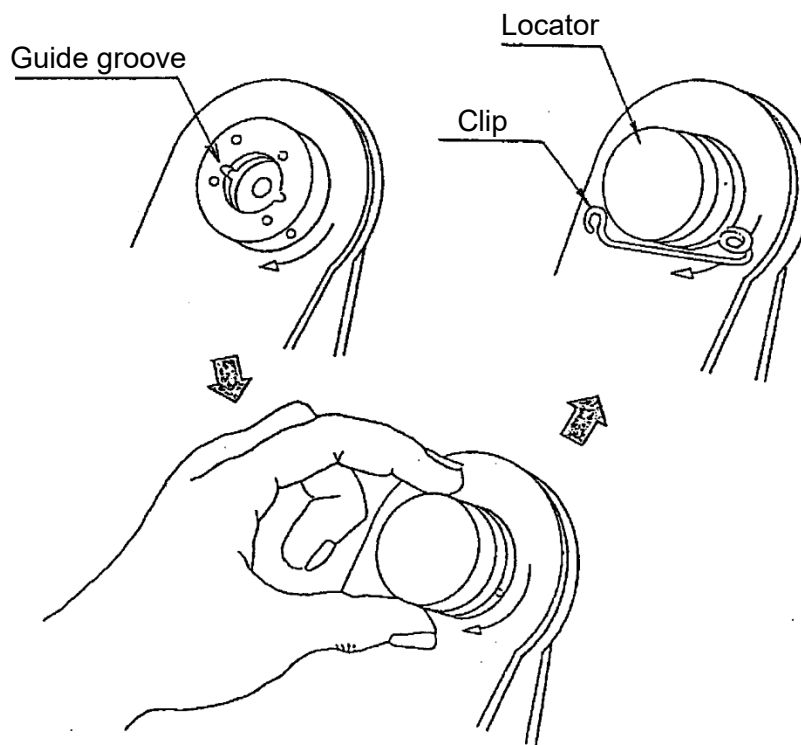


**Figure 8. Inspection Pin Gauge**

(2) Crimping tool setting

- (a) Attach the locator shown in Table 2. to the crimping tool.

Remove the clip from the tool and push the locator guided by the grooves. Rotate the locator clockwise all the way to the end. The locator slightly goes back after it hit the end. Insert the clip back to the tool (See Figure 9).



**Figure 9. Attaching Locator**

- (b) Set the selector number by rotating the knob according to the part number of contact and wire size as specified in Table 5. Secure the knob with the clip to keep the knob from rotating during the crimping operation.

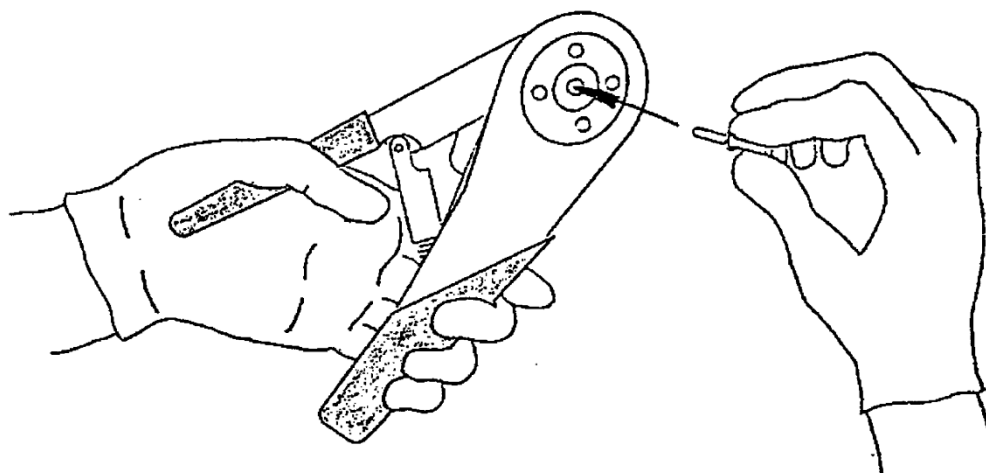
**Table 5. Applicable Selector Number**

Contact Part Number	Wire size (AWG)	Selector number
ND104-P-C22D ND104-S-C22D	22	4
	24	3
	26	2
	28	1

- (c) To verify that the tool is in a good condition, operate the tool a few times.  
The handle shall be fully tightened to the ratchet release position as it is not released in the mid way.

(3) Contact insertion

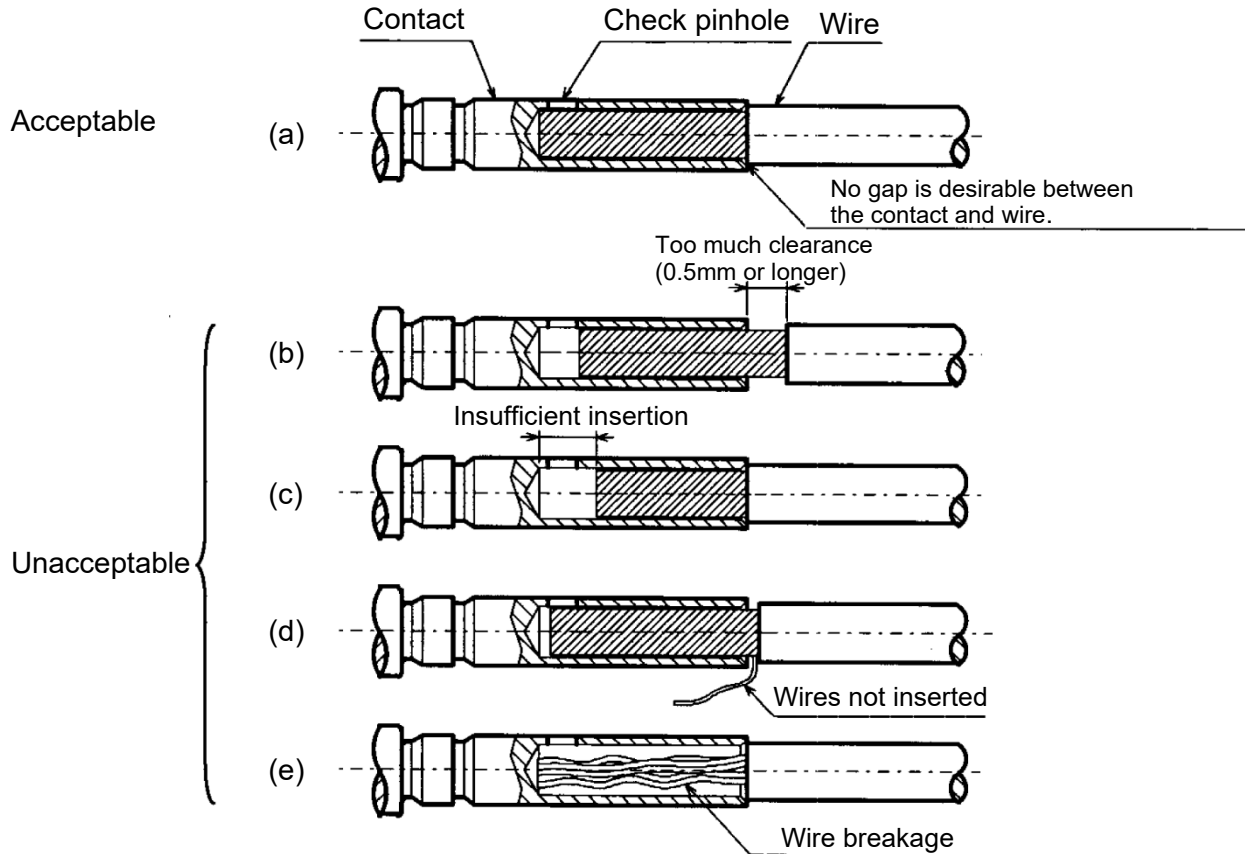
Insert the contact into the crimping hole of the tool (See Figure 10).



**Figure 10. Contact Insertion**

(4) Wire insertion

Insert the bare conductor without the jacket into the contact deeper than the check pinhole on the contact (See Figure 11).



**Figure 11. Wire Insertion**

(5) Crimping

While pushing the wire lightly toward the contact to ensure a proper insertion length, tighten the handle gradually until the ratchet is released.

(6) Contact extraction

After the contact is crimped, stop tightening the handle. The handle automatically returns to the original position by its inner spring and the jaw opens. The crimped contact can be easily extracted by pulling the wire lightly. The contact cannot be extracted until the handle opens fully.

(7) Inspection of crimped contacts

The following items shall be checked for crimped contacts.

- (a) The wire insertion condition shall not be any of “unacceptable” examples shown in Figure 11.
- (b) The jaw teeth shall be positioned at a point close to the center between the contact edge and the check hole (See Figure 12).
- (c) The contact is free of extreme scratches or cracks.

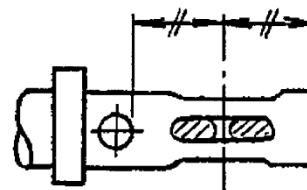


Figure 12. Jaw Teeth Position

Crimp tensile strength required for the contacts is shown in Table 6. for information only. Users are encouraged to check the crimp tensile strength using left-over contacts and wires occasionally.

Table 6. Crimp Tensile Strength

Contact number	Wire size (AWG)	Min. crimp tensile strength N {kgf}	Wire specification
ND104-P-C22D ND104-S-C22D	22	57{5.81}	JAXA-QTS-2120 or equivalent
	24	36{3.67}	
	26	36{3.67}	
	28	22{2.24}	

3.2.3 Contact Installation

(1) Preparing insertion tool

An insertion tool specified in Table 2. shall be prepared.

(2) Insertion tool setting

Mount the wire into the cylindrical tip of tool, and move the tool along the wire till the tool tip touches the contact retention area.

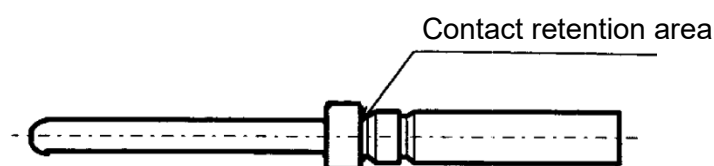
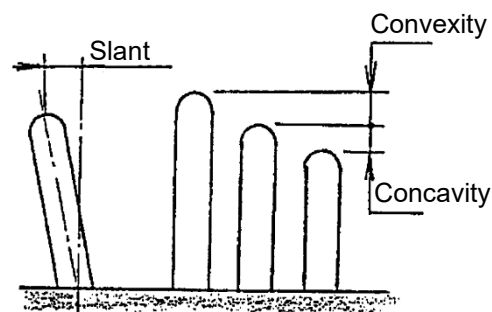


Figure 13. Contact Retention Area

(3) Contact insertion

Hold the wire mounted tool with fingers and insert the contact from the insulator hole (grommet hole) at the connector rear surface.

- (4) Contact retention check  
Pull the wire backward with 9.8N {1kgf} force to confirm that the contact has been installed in the connector.
- (5) Inspection of installed condition
  - (a) For the pin connectors, verify the pin contacts from the mating side for slant and height (See Figure 14).  
Generally, slants or height variations that are less than 0.5mm do not pose any risk if there is looseness for the contacts to correct the slants or the height variations.
  - (b) For the socket connectors, proper looseness in the insulator holes shall be verified.



**Figure 14.**  
**Slant and Unevenness of Contact**

#### 3.2.4 Contact Replacement

When installed contacts need to be replaced for reasons such as wrong wiring and circuit design modification, follow the procedure given below.  
The right angle through hole contacts cannot be replaced.

- (1) Preparing removal tool  
Prepare a removal tool specified in Table 2.
- (2) Removal tool setting  
Insert the wire into the cylindrical tip of tool, and insert the tool tip into the insulator hole along the wire.
- (3) Contact extraction  
When the tool tip reaches the contact shoulder, the contact retention clip comes off from the contact shoulder.  
Hold and pull straight the wire and tool together to extract the contact.  
The contact cannot be extracted if the tool tip insertion is insufficient or if the wire is pulled before the tool.

#### 3.2.5 Soldering

Right angle through hole

Install the connector on a PWB securely using screws or by other methods and solder at the through hole.

Remove residue flux after soldering.

### 3.3 Dimensions for Mounting Holes

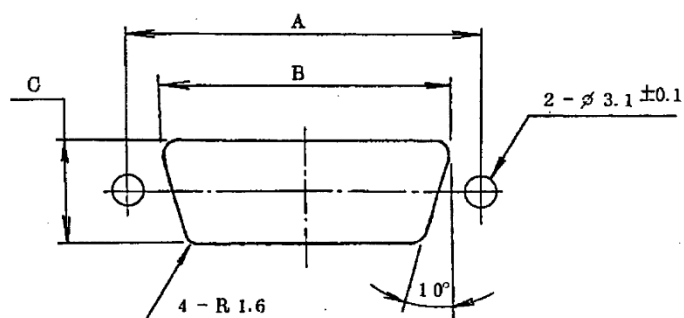
#### 3.3.1 Crimp and Soldering Type Connectors

Recommended dimensions for the mounting holes on a panel are shown in Table 7.

**Table 7. Dimensions for Mounting Hole**

Unit: mm

No. of contacts	$A \pm 0.15$	$B \pm 0.2$	$C \pm 0.2$
104	63.5	59.9	16.0

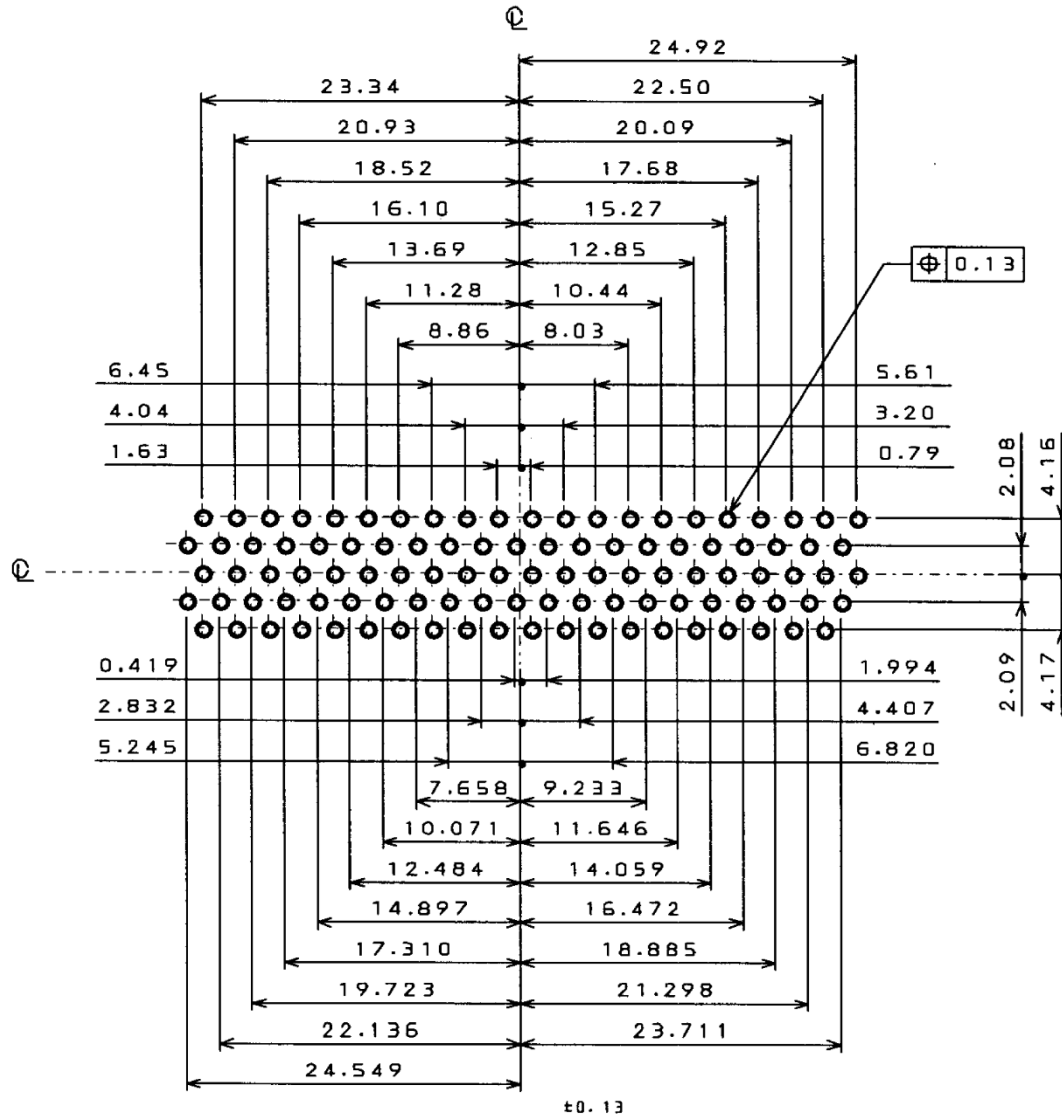


**Figure 15. Dimensions for Mounting Holes**

### 3.3.2 Right Angle Through Hole Type Connectors

Recommended dimensions for the through holes on a PWB are shown in Figure 16.  
Through hole diameters shall be  $\Phi 0.8\text{mm}$  as a minimum.

Unit: mm



104 contacts (PIN)



Figure 16. Dimensions for Through Holes on PWB

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 17 –
JAHL-3300			
3.4 Precautions			
3.4.1 Wiring			
<ul style="list-style-type: none"> <li>(1) After connectors and contacts are removed from a sealed bag, wear clean white gloves or finger cots to handle them.</li> <li>(2) When right angle through hole type connectors are cleaned for residue flux, ensure that flux doesn't adhere to the contact surfaces.</li> </ul>			
3.4.2 Assembly			
<ul style="list-style-type: none"> <li>(1) The locator attached to the right angle thorough hole type connector shall be detached prior to mounting the connector to a PWB by unlocking both sides of the locator. Use caution not to bend or damage the contacts while detaching the locator.</li> <li>(2) To bind the wires, allow sufficient slack for the wires so that the contacts can align straight. If the wires are bent significantly and bound at a point close to the connector rear face, the contacts may stay slanted, the wire-contact junction may be over stressed, and/or mating becomes difficult.</li> <li>(3) To pot the connector rear face, use a potting material that has an appropriate viscosity to prevent the material from flowing into the connector. In addition, the opposite connector (jig) shall be mated to prevent the contacts from slanting.</li> </ul>			
3.4.3 Electrical Conductivity Check			
<ul style="list-style-type: none"> <li>(1) Use the opposite connector or an individual contact not to damage the contact in checking the electrical conductivity.</li> <li>(2) To test an individual contact, insert the contact straight not to generate bending moments on the contact under test.</li> </ul>			
3.4.4 Mating and Unmating			
<p>Mating and unmating the connectors shall be performed gently in parallel with the mating axis. Do not attempt to mate or unmate the connectors by applying forces not in parallel with the mating axis.</p>			



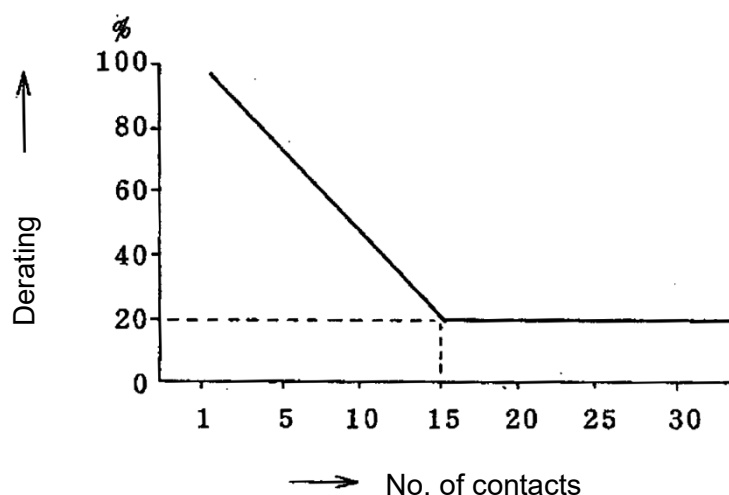
JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 18 –
JAHL-3300			
4. CHARACTERISTICS UNDER NORMAL OPERATING CONDITIONS			
4.1 Ratings			
(1) Rated voltage: At barometric pressure····· 330V <sub>AC</sub>			
At reduced pressure ······ 100V <sub>AC</sub> (70,000ft)			
(2) Operating temperature range: -65 to +125°C			
(3) Applicable wires: AWG 22 to 28			
4.2 Electrical Characterisitcs			
(1) Insulation resistance: 5,000MΩ min.			
(2) Dielectric withstanding voltage: 1,000V <sub>AC</sub>			
(3) Contact resistance: 7.3mΩ max. (AWG 22)			
(4) Current: 5A per contact			
4.3 Mechanical Characteristics			
(1) Operation life: 500 times of mating and demating operations			
(2) Vibration: High frequency vibration··· 10 to 2,000Hz, 294m/s <sup>2</sup> {30G} peak			
Random vibration ······ 333.6m/s <sup>2</sup> rms effective acceleration {34.02Grms}			
(3) Shock: Shock (I)··········· 2,942m/s <sup>2</sup> {300G}, 3ms			
Shock (II)··········· 14,710m/s <sup>2</sup> {1,500G}, 0.5ms			
4.4 Thermal Characteristics			
(1) Thermal shock: Temperature cycle (I)··· -65 to +125°C, 5 cycles			
Temperature cycle (II)·· -30 to +100°C, 1,000 cycles			

#### 4.5 Current Capacity

Although the maximum current is defined for each contact size and wire size, the maximum total current for the connector needs to be defined to limit the temperature rise. MIL-W-5088 specifies the current derating as shown in Table 8.

**Table 8. Current Derating**

No. of contacts	Derating (%)	No. of contacts	Derating (%)
1	100	9	54.3
2	94.3	10	48.6
3	88.6	11	42.9
4	82.9	12	37.1
5	77.1	13	31.4
6	71.4	14	25.7
7	65.7	15 or more	20.0
8	60.0		



**Figure 17. Current Derating Chart**

In the case of 104 contacts, the maximum total current is calculated as follows:

$$\begin{aligned} A &= \text{Contact current capacity} \times \text{no. of contacts} \times \text{derating} \\ &= 5\text{A} \times 104 \text{ contacts} \times 20.0\% \\ &= 104.0\text{A} \end{aligned}$$

Even though a maximum of 5A can be flown through each contact, the total current for the connector is limited to a maximum of 104.0A.

#### 4.6 Temperature Rise

When currents flow a connector, the connector temperature rises. The temperature rise inside the mated area was measured at ambient temperature by applying 1A to 5A

JABL-3300

currents using ND114-104P-CR and ND114-104S-CR with all contacts connected in series.

Temperature (°C)

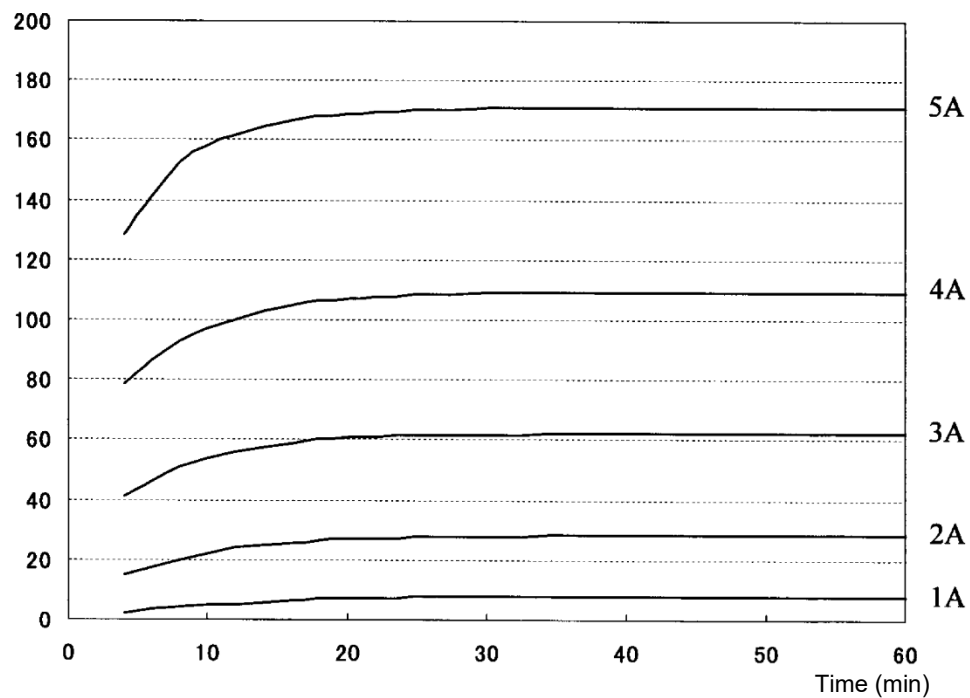


Figure 18. Temperature Rise inside Mated Area (Center) at Each Current

#### 4.7 Breakdown Voltage

The breakdown voltages of the connectors are as shown in Table 9. at the normal condition.

EIA-364-20 specifies the rated voltage as one third of the dielectric withstanding voltage and the dielectric withstanding voltage as 75% of the breakdown voltage. However, the breakdown voltage of the connectors covered in this data sheet is approximately 5 times of the rated voltage. The connector has a sufficient margin against transient excessive voltages such as voltages generated at switching, surge voltages and other similar transient voltages if the operating voltage doesn't exceed the rated voltage shown in Table 9.

In practical usage, ensure that the connector insulator surface is free of dusts and water adhesion.

**Table 9. Voltage**

	V <sub>AC</sub>	Remark
Rated voltage	330	
Dielectric withstanding voltage	1,000	
Breakdown voltage	1,600 to 3,500	Between contacts
	3,000 to 3,500	Between contacts and shell

#### 5. CHARACTERISTICS UNDER VARIOUS OPERATING CONDITIONS AND ENVIRONMENTAL LIMITS

In this section, the connector characteristics under various environmental conditions and environmental limits of the connector are described based on the quality conformance inspection and breakdown limit test data.

##### 5.1 Salt Spray

The connectors have superior corrosion resistance because the metal parts are gold plated of an appropriate thickness and because there is no contact between dissimilar metals.

The salt spray test was performed in accordance with EIA-364-26 for 96 hours which is twice as long as that is specified in appendix D of JAXA-QTS-2060 (48 hours).

As a result, although corrosion was found at the crimped area of contacts, there was no corrosion or discoloration that could affect the connector performance. The following test results met the requirements specified in appendix D of JAXA-QTS-2060.

[Test condition]

Salt concentration: 5%

Temperature: 35°C

[Test items]

External and construction

Mating and unmating forces

Contact engagement and separation forces

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 22 –
<div data-bbox="1297 190 1461 224" data-label="Text">JAHL-3300</div> <div data-bbox="276 271 743 387" data-label="Text"> <p>Low-signal level contact resistance Contact resistance Crimp tensile strength</p> </div> <div data-bbox="276 432 716 504" data-label="Text"> <p>[Test samples] Connector and individual contact</p> </div> <div data-bbox="180 548 421 582" data-label="Section-Header"> <h2>5.2 Sulfidation</h2> </div> <div data-bbox="276 595 1418 712" data-label="Text"> <p>Individual contacts were tested in accordance with IEC 60068-2-46 for resistance to sulfidation environments, to which the contacts may be exposed during storage and/or ground testing.</p> </div> <div data-bbox="276 712 1461 831" data-label="Text"> <p>As a result, although corrosion was found at the crimped area of contacts, there was no corrosion or discoloration that could affect the connector performance. The following test results met the requirements specified in appendix D of JAXA-QTS-2060.</p> </div> <div data-bbox="276 875 799 1068" data-label="Text"> <p>[Test conditions] Hydrogen sulfide concentration: 15ppm Relative humidity: 75%RH Temperature: 25°C Test duration: 500 and 1,000 hours</p> </div> <div data-bbox="276 1113 743 1265" data-label="Text"> <p>[Test items] External and construction Low-signal level contact resistance Contact resistance</p> </div> <div data-bbox="276 1310 515 1386" data-label="Text"> <p>[Test samples] Individual contact</p> </div> <div data-bbox="180 1431 399 1467" data-label="Section-Header"> <h2>5.3 Humidity</h2> </div> <div data-bbox="276 1478 1402 1554" data-label="Text"> <p>The humidity test was performed in accordance with EIA-364-31 for 504 hours that is more than twice the duration specified in appendix D of JAXA-QTS-2060,.</p> </div> <div data-bbox="276 1554 1449 1635" data-label="Text"> <p>As a result, although corrosion was found at the crimped area of contacts, there was no corrosion or discoloration that could affect the connector performance.</p> </div> <div data-bbox="276 1635 1422 1756" data-label="Text"> <p>Though the connectors are not of an environment resistant type, inside of which is sealed, no degradation of the insulation performance was observed. The following test results met the requirements specified in appendix D of JAXA-QTS-2060.</p> </div> <div data-bbox="276 1796 703 1915" data-label="Text"> <p>[Test conditions] Temperature: 65°C Relative humidity: 90 to 98%RH</p> </div> <div data-bbox="276 1957 620 2072" data-label="Text"> <p>[Test items] External and construction Insulation resistance</p> </div>			

Dielectric withstanding voltage  
Mating and unmating forces

[Test samples]  
Connectors

#### 5.4 Thermal characteristics

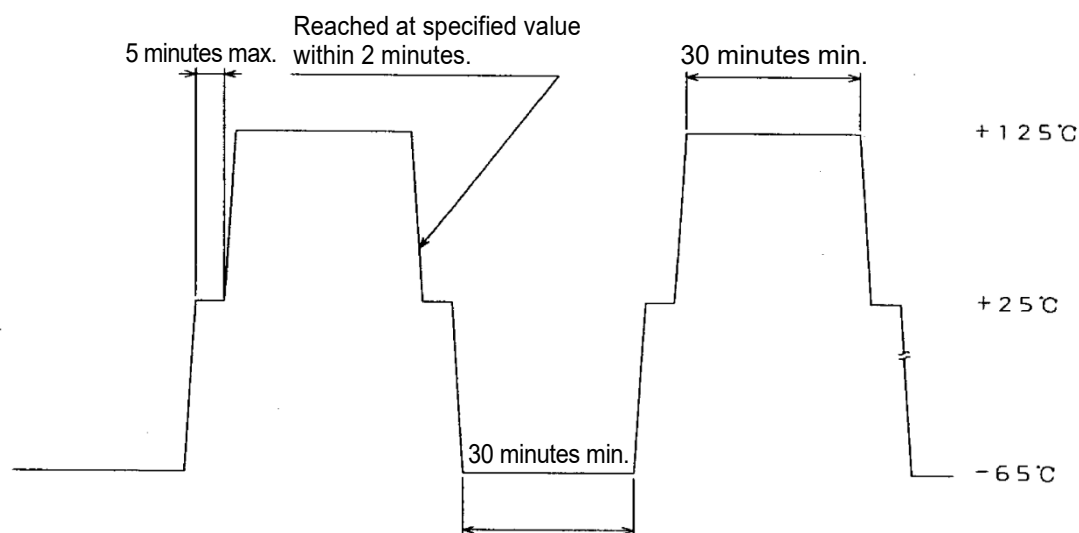
Thermal characteristic tests included temperature cycling test, temperature life test and thermal vacuum test.

As a result, although the temperature life test resulted in discoloration of the insulator, there were no loose chips, cracks, peeled plating, discoloration, degradation of the contacting surfaces and the crimped area of the contacts or degradation of the insulator performance. The following test results met the requirements specified in appendix D of JAXA-QTS-2060.

##### 5.4.1 Temperature Cycling

Appendix D of JAXA-QTS-2060 requires 5 cycles at -65 to +125°C for the temperature cycling test. However, the temperature cycling test was performed for 100 cycles at -65 to +125°C as an environmental limit test

[Test conditions]



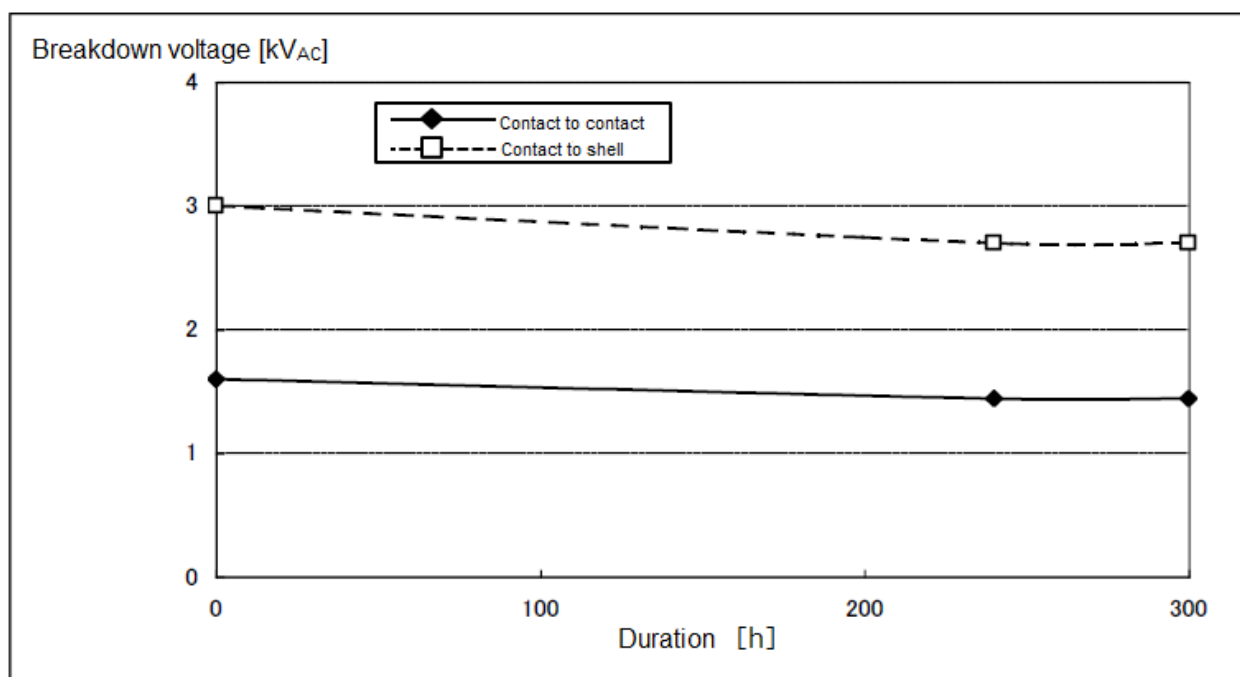
**Figure 19. Temperature Cycling Test Condition Chart**

[Test items]  
External and construction  
Insulation resistance  
Dielectric withstanding voltage  
Mating and unmating forces  
Contact engagement and separation forces

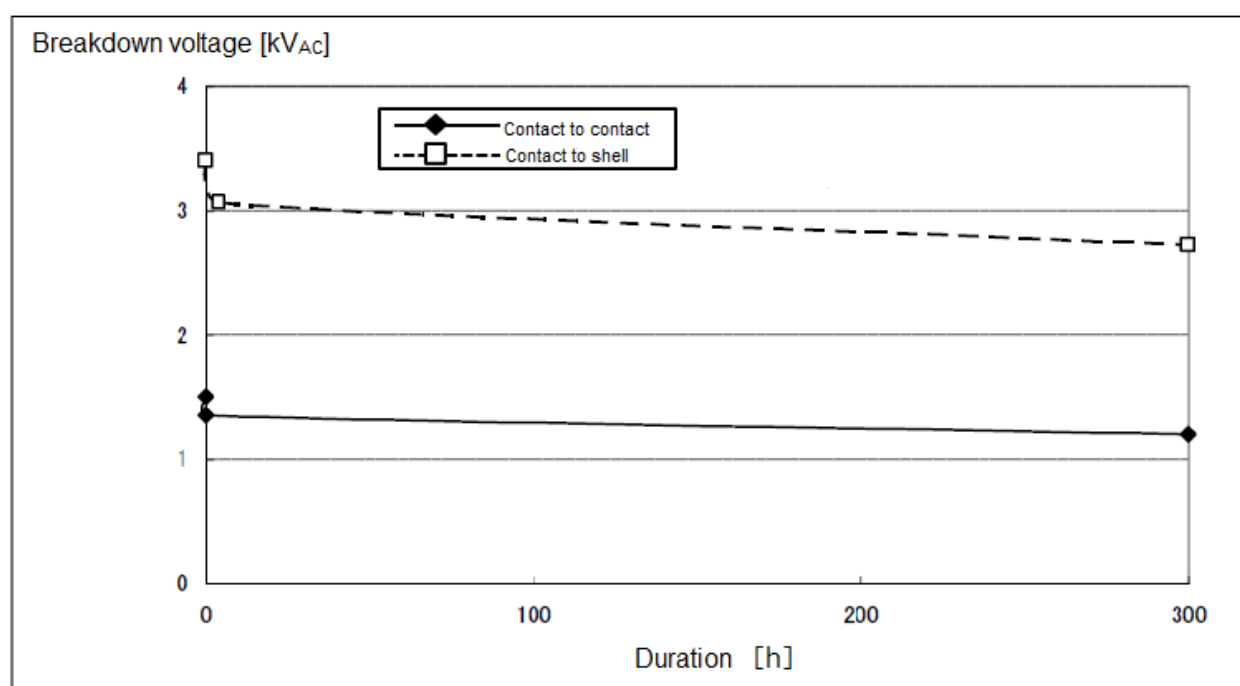
JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 24 –
JAHL-3300			
<p>Low-signal level contact resistance Contact resistance Crimp tensile strength</p> <p>[Test samples] Connectors and individual contact</p>			
<p>5.4.2 Temperature Life</p> <p>The temperature life test was performed in accordance with EIA-364-17 for 2000 hours which is twice as long as that is required in appendix D of JAXA-QTS-2060.</p> <p>[Test condition] Temperature: +125°C (constant)</p> <p>[Test items] External and construction Insulation resistance Dielectric withstanding voltage Contact engagement and separation forces Low-signal level contact resistance Contact resistance Crimp tensile strength</p> <p>[Test samples] Connectors and individual contact</p>			
<p>5.4.3 Thermal Vacuum</p> <p>After maintaining the connectors in a vacuum of <math>1 \times 10^{-4}</math> Pa or less at a temperature of -65°C and +125°C for 3 hours each, and the following items were examined.</p> <p>[Test items] External and construction Insulation resistance Dielectric withstanding voltage Contact resistance</p> <p>[Test samples] Connectors</p>			
<p>5.5 Dielectric Withstanding Voltage</p> <p>To understand the withstand voltage characteristics, dielectric withstanding voltage (life) test and dielectric withstanding voltage (altitude) test were conducted.</p>			

### 5.5.1 Dielectric Withstanding Voltage (Life)

90%, 80%, 70%, and so on of the breakdown voltage was applied and time to breakdown was measured. The result is as shown in Figure 20.

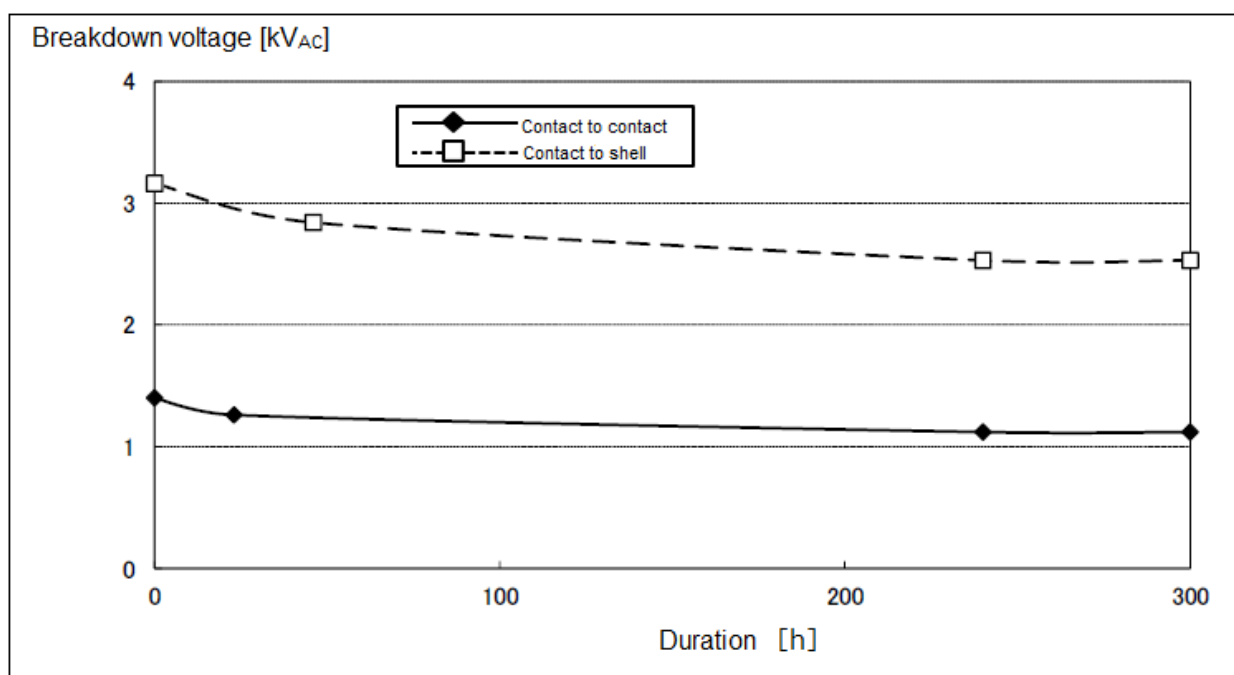


**Figure 20-1. Dielectric Withstanding Voltage (Life)**  
(Insulator: white, curing agent for adhesive: 15 CLEARJ)

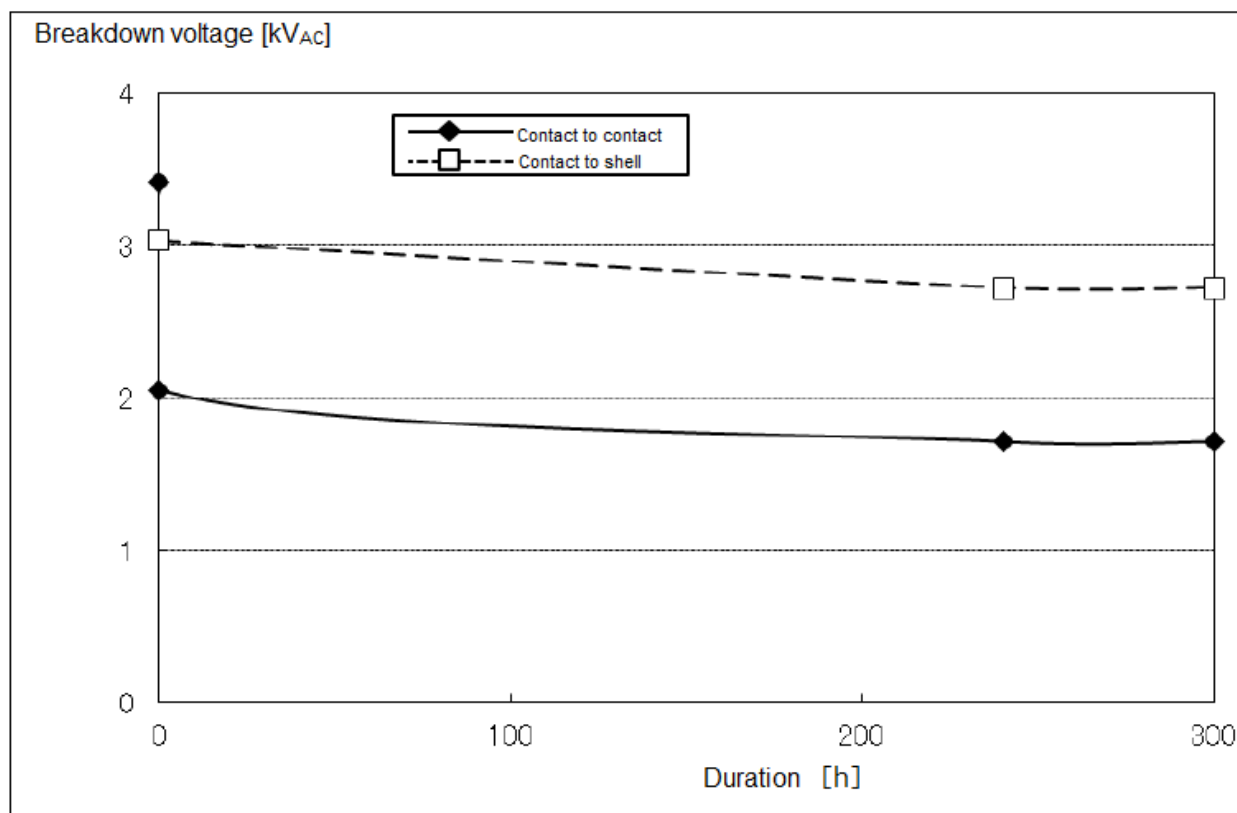


**Figure 20-2. Dielectric Withstanding Voltage (Life)**  
(Insulator: black B, curing agent for adhesive: 15 CLEARJ)

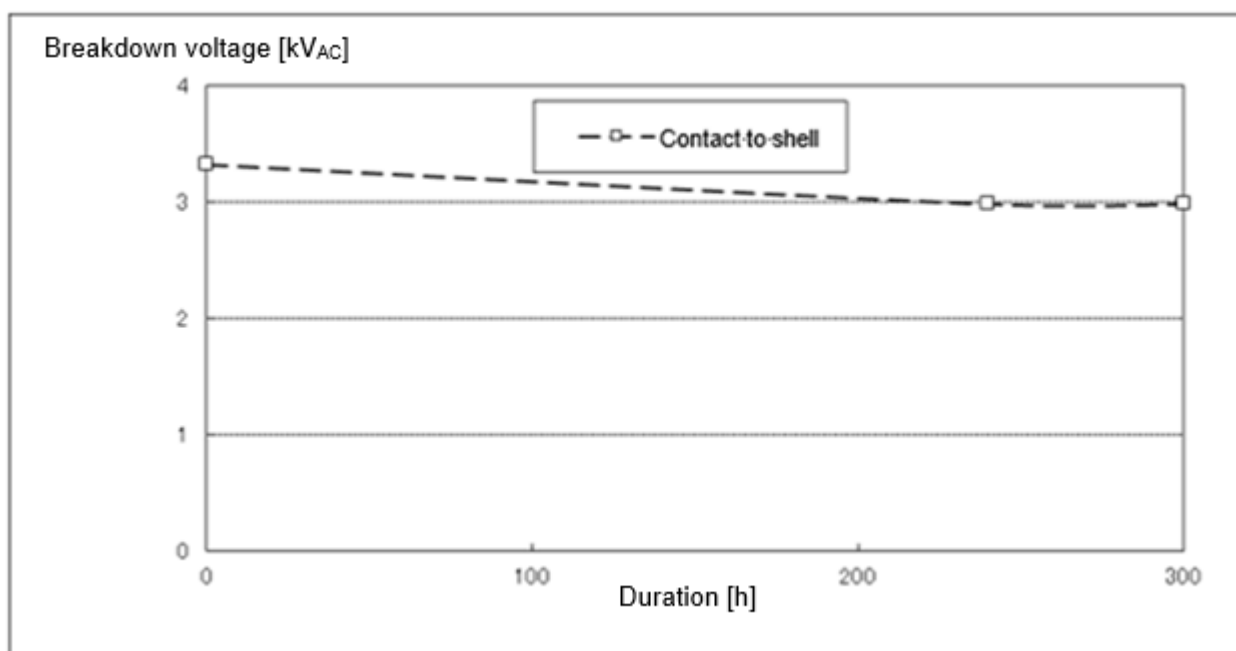




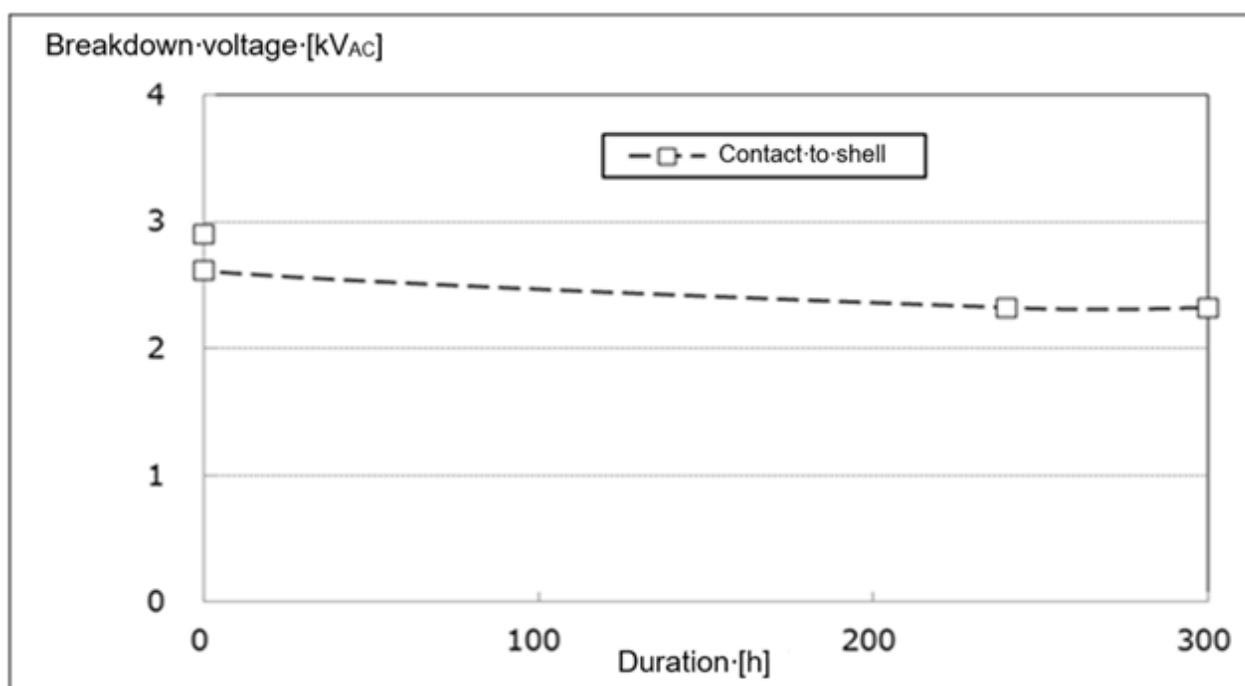
**Figure 20-3. Dielectric Withstanding Voltage (Life)**  
(Insulator: black B, curing agent for adhesive: 15-1 CLEARJ)



**Figure 20-4. Dielectric Withstanding Voltage (Life)**  
(Insulator: black BS, curing agent for adhesive: 15-1 CLEARJ)



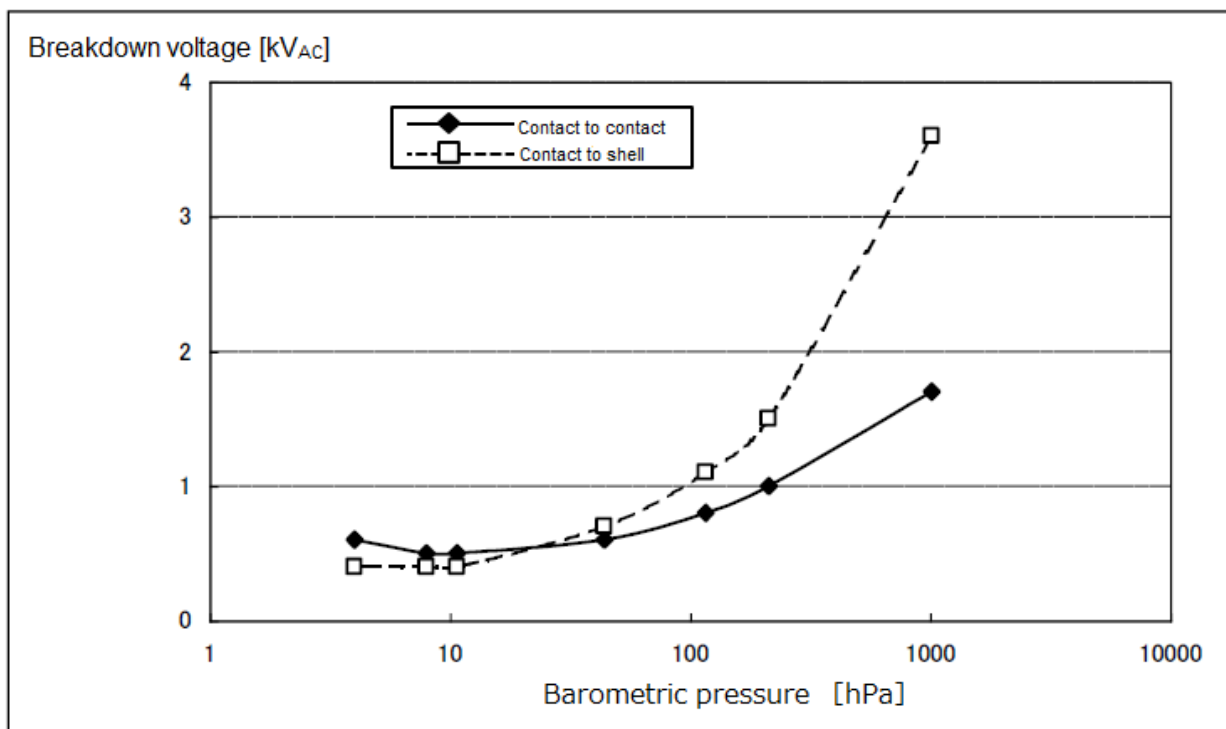
**Figure 20-5. Dielectric Withstanding Voltage (Life)**  
(Insulator: black B, adhesive:TB2234H)



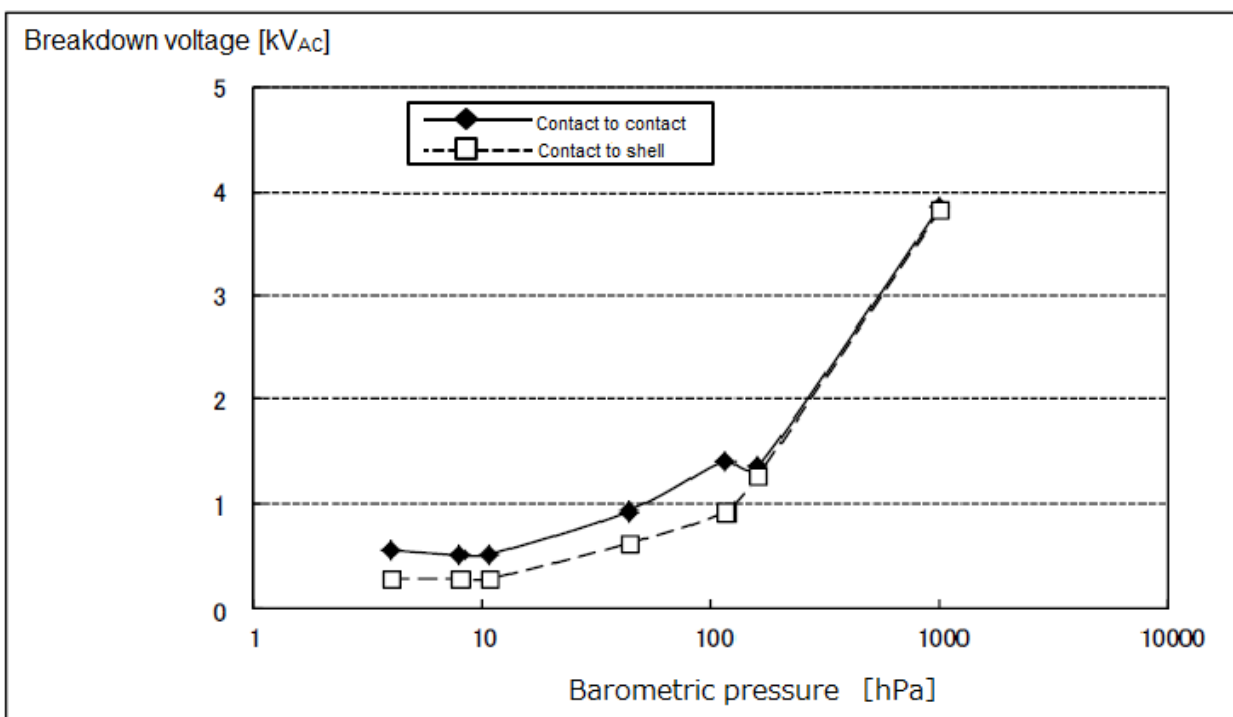
**Figure 20-6. Dielectric Withstanding Voltage (Life)**  
(Insulator: black BS, adhesive: TB2270C)

### 5.5.2 Dielectric Withstanding Voltage (Altitude)

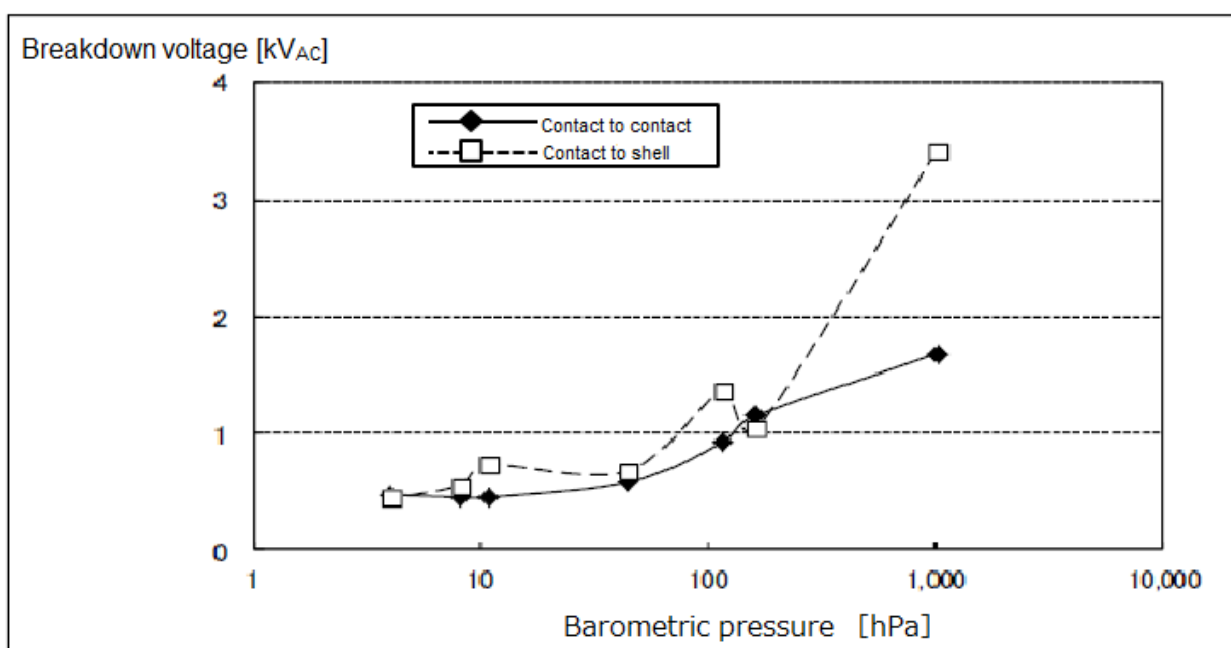
The breakdown voltage was measured at various barometric pressures that simulate barometric pressures at various altitudes between the ground and space. The results are shown in Figures 21-1, 21-2, 21-3 and 21-4. The connectors operate normally if used at 100V<sub>AC</sub> which is the rated voltage at a reduced pressure.



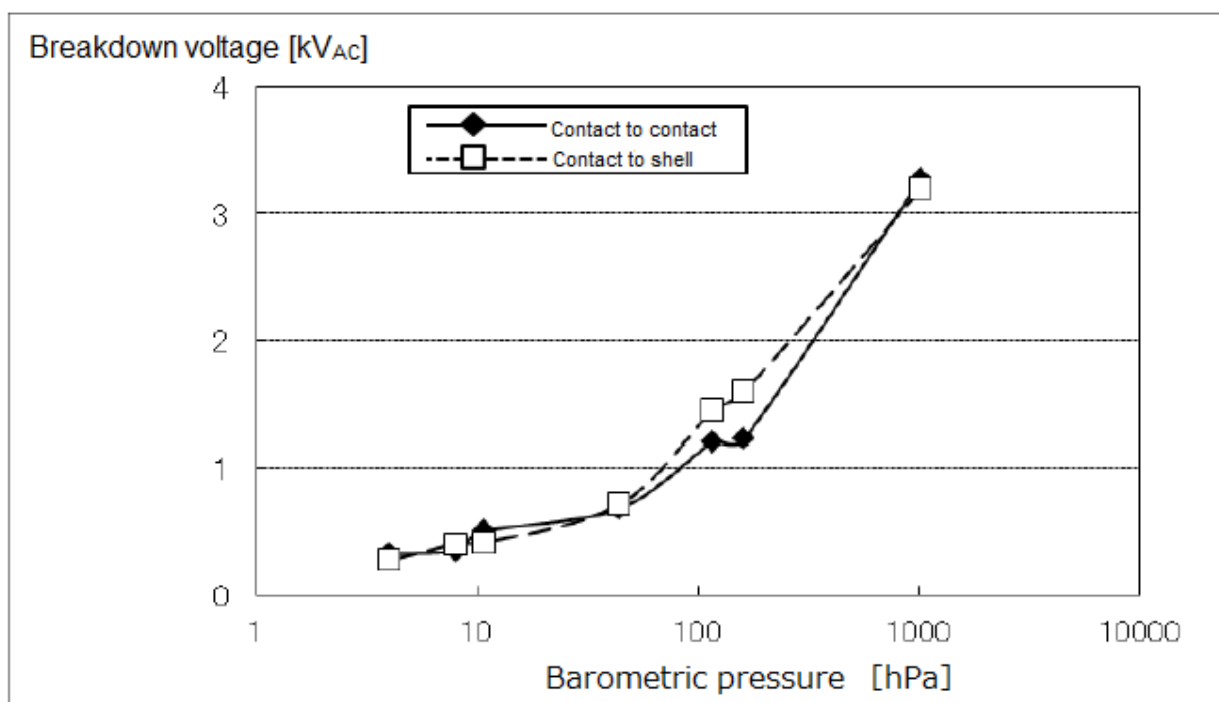
**Figure 21-1. Dielectric Withstanding Voltage (Altitude)**  
(Insulator: white, curing agent for adhesive: 15 CLEARJ)



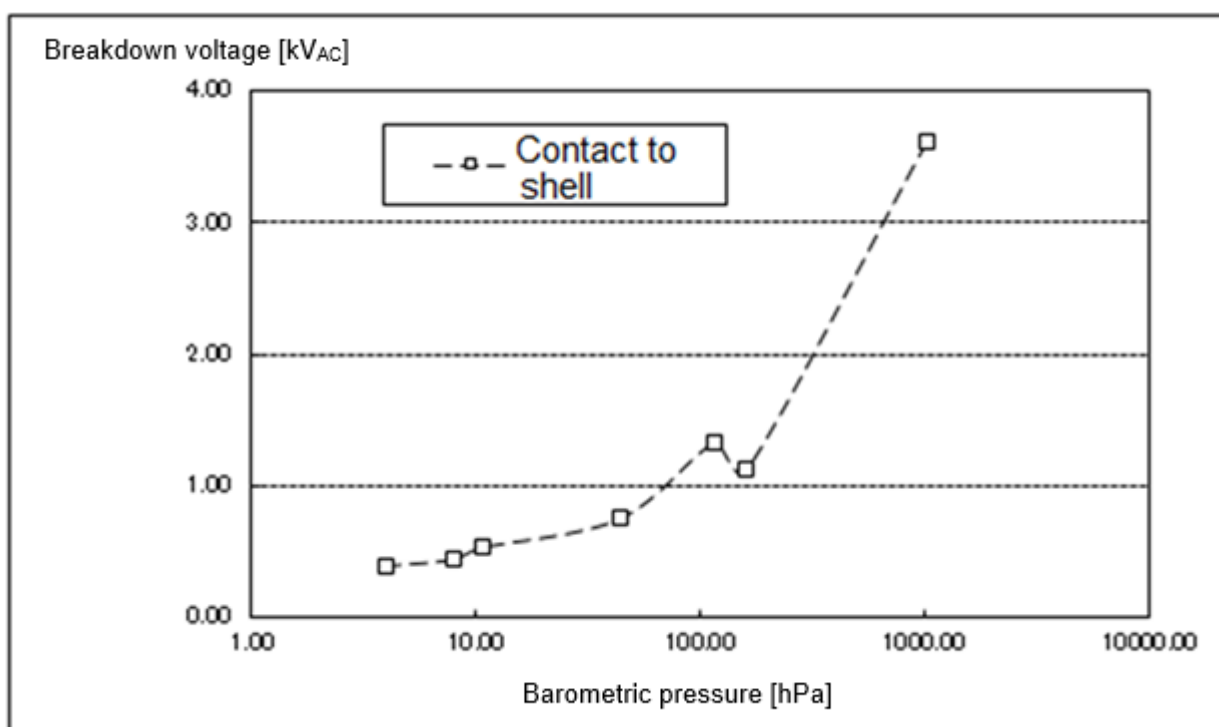
**Figure 21-2. Dielectric Withstanding Voltage (Altitude)**  
(Insulator: black B, curing agent for adhesive: 15 CLEARJ)



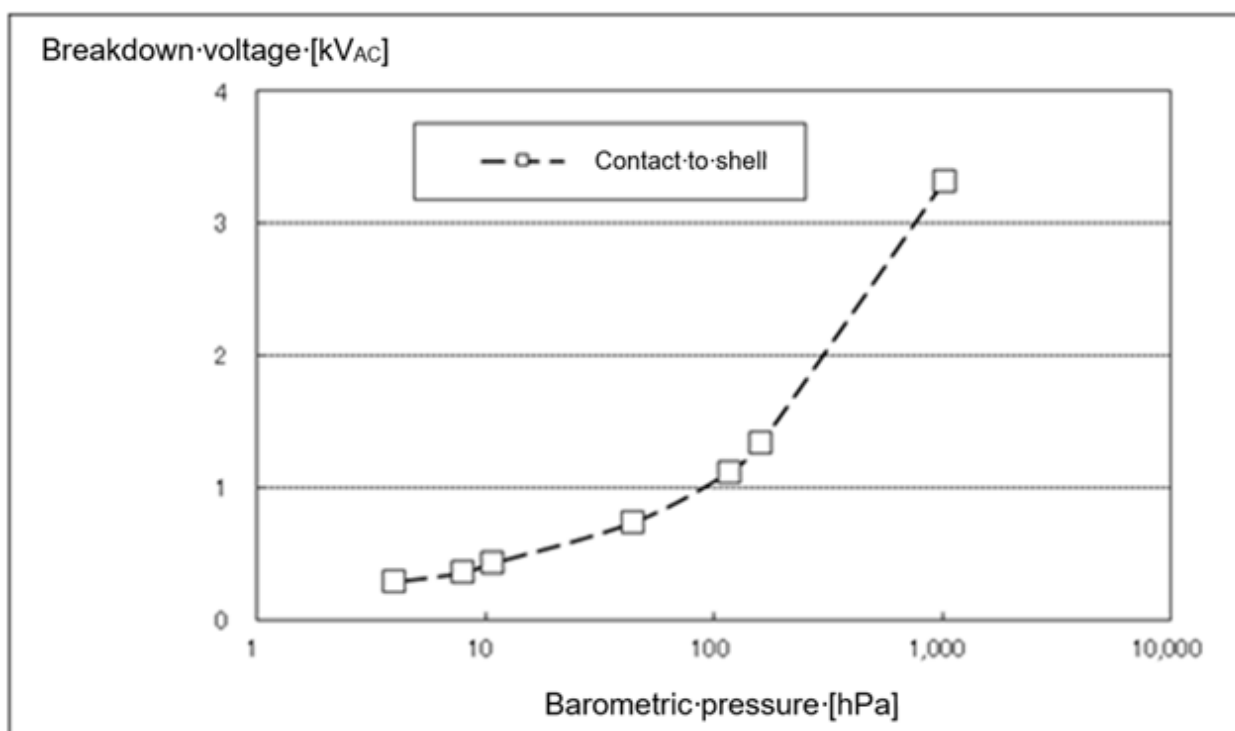
**Figure 21-3. Dielectric Withstanding Voltage (Altitude)**  
(Insulator: black B, curing agent for adhesive: 15-1 CLEARJ)



**Figure 21-4. Dielectric Withstanding Voltage (Altitude)**  
(Insulator: black BS, curing agent for adhesive: 15-1 CLEARJ)



**Figure 21-5. Dielectric Withstanding Voltage (Altitude)**  
(Insulator: black B, adhesive: TB2234H)



**Figure 21-6. Dielectric Withstanding Voltage (Altitude)**  
(Insulator: black BS, adhesive: TB2270C)

## 5.6 Vibration

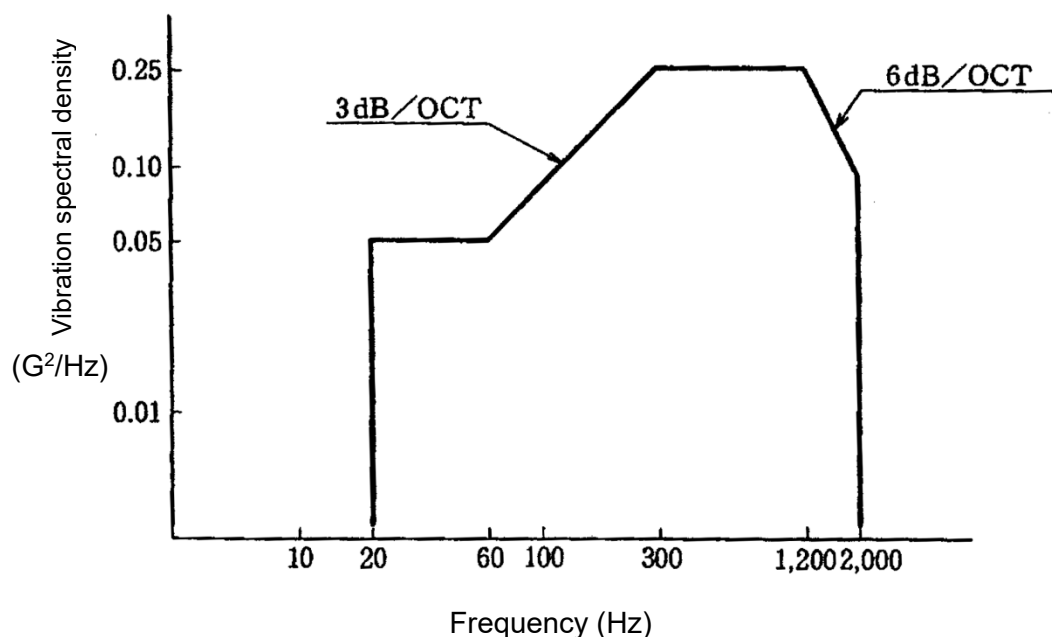
Vibration tests included high frequency vibration test and random vibration test. Though wear of the contact plating was observed due to the vibration, no intermittent current discontinuity during the test duration or loosened parts were detected, which met the requirements specified in appendix D of JAXA-QTS-2060. In addition, post-test measurements of the contact resistance, the dielectric withstanding voltage and the insulation resistance met the requirements.

### 5.6.1 High Frequency Vibration

The high frequency vibration test was performed in accordance with test method 204 of MIL-STD-202 at 20 to 2,000Hz, 490m/s<sup>2</sup> {50G} peak, 3 axes for 12 hours in total. The test condition specified in appendix D of JAXA-QTS-2060 is 20 to 2,000Hz, 294m/s<sup>2</sup> {30G} peak.

### 5.6.2 Random Vibration

The random test was conducted in the positive and negative directions along 3 axes for 90 seconds in each direction. Figure 22 shows the vibration spectral envelope.



**Figure 22. Vibration Spectral Envelope for Random Vibration Test (19.6Grms)**

## 5.7 Shock

The shock test was conducted in the positive and negative directions along 3 axes for 3 times in each direction under the test conditions of  $2942\text{m/s}^2$  {300G} and  $14710\text{m/s}^2$  {1500G} as specified in appendix D of JAXA-QTS-2060.

As a result, intermittent current discontinuity of  $1\mu\text{s}$  or more as specified in appendix D of JAXA-QTS-2060 was not detected and there were no separation, damage, crack or slackness found at the connector joints, and this met the requirements specified in appendix D of JAXA-QTS-2060.

## 5.8 Operating Life

The operating life test was performed by repeating the mating and unmating operation 1,000 times, which is twice the number specified in appendix D of JAXA-QTS-2060 (500 times).

As a result, though the contact bare metal was exposed, there was no degradation in the contact elasticity that affects the contact performance. The following test results met the requirements specified in appendix D of JAXA-QTS-2060.

[Test items]

External and construction

Mating and unmating forces

Contact engagement and separation forces

Contact resistance

Contact retention

## 5.9 Creep at Crimped Area

Wire of the proper gauge was crimped to the contact. Time from the application of the axial static load specified in Table 10. at an ambient temperature to a point when the wire was detached or broken was measured.

The wire wasn't detached or broken for at least 3,000 hours.

[Test condition]

The static loads which were equal to 10% and 15% of the crimp tensile strength (the breakdown point) were applied at the crimped area.

**Table 10. Creep at Crimped Area**

Contact	Wire (AWG)	Static load N{gr}	
		10%	15%
22D	Annealed copper wire	28	330
		26	570
		24	850
		22	960
			1,440



## 5.10 Outgassing

The outgassing test was conducted in accordance with ASTM E595-77 for organic materials used for the connectors. The results are shown in Table 11-1. The outgassing data calculated from the mass ratio of each material to the entire organic materials met the requirements specified in paragraph 3.3.2 of JAXA-QTS-2060 as shown in Table 11-2.

**Table 11-1. Outgassing Test Results for Each Organic Materials**

Material	Application	TML	CVCM	WVR
Diallyl phthalate resins (White)	Insulator <sup>(1)</sup>	0.550±0.006	0.014±0.003	0.102±0.001
Diallyl phthalate resins (AM113J Black B)	Insulator <sup>(1)</sup>	0.538±0.005	0.015±0.001	--
Diallyl phthalate resins (AM113J Black BS)	Insulator <sup>(1)</sup>	0.500±0.005	0.001±0.000	0.141±0.001
Epoxy adhesive (Curing agent:15 CLEARJ)	Insulator adhesion <sup>(2)</sup>	5.461±0.059	0.483±0.006	0.772±0.004
Epoxy adhesive (Curing agent:15-1 CLEARJ)	Insulator adhesion <sup>(2)</sup>	3.392±0.054	0.035±0.001	--
Epoxy adhesive (TB2224)	Press pin adhesion and potting <sup>(3)</sup>	0.570±0.059	0.163±0.006	0.141±0.006
Epoxy adhesive (TB2234H)	Press pin adhesion and potting <sup>(3)</sup>	0.745±0.004	0.000±0.000	0.238±0.004
Epoxy adhesive (TB2270C)	Press pin adhesion and potting <sup>(3)</sup>	0.541±0.006	0.003±0.000	0.175±0.003
Marking ink (Black)	Part no. marking	18.859±0.608	0.082±0.001	0.411±0.004
Silicon resin	Grommet	0.944±0.013	0.271±0.005	0.610±0.006
Silicon resin	Potting	4.628±0.098	0.173±0.004	0.040±0.001
Silicon resin	Grommet adhesive	1.669±0.003	0.658±0.011	0.003±0.000

{ TML : Total Mass Loss  
CVCM : Collected Volatile Condensable Materials  
WVR : Water Vapor Regained

## Notes:

- (1) Three types of insulator materials are used: AM113J White, AM113J Black B and AM113 black BS. For actual use, the AM113J black BS shall come before the others.
- (2) Two types of epoxy curing agents; 15 CLEARJ and 15-1 CLEARJ. For actual use, epoxy adhesive using 15 CLEARJ shall come before the adhesive using 15-1 CLEARJ. The adhesive using 15-1 CLEARJ is not used for the products with the white insulator.
- (3) Three types of epoxy adhesives; TB2224, TB2234H and TB2270C. For actual use, epoxy adhesive using TB2270C shall come before the adhesive using others.

JAHL-3300

**Table 11-2. Results of Outgas Mass Distribution Calculation**Requirements  
TML: 1% or less  
CVCM: 0.1% or less

ND114-104P-CR (Insulator: white/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.322±0.007	0.550±0.006	0.014±0.003	0.00727±0.00012	0.00019±0.00004
R insulator	4.790±0.032	0.550±0.006	0.014±0.003	0.02635±0.00047	0.00067±0.00015
Grommet adhesive	0.020±0.003	1.669±0.003	0.658±0.011	0.00033±0.00005	0.00013±0.00002
Potting	0.465±0.015	0.570±0.059	0.163±0.006	0.00265±0.00037	0.00076±0.00005
Insert adhesive	0.017±0.0025	5.461±0.059	0.483±0.006	0.00093±0.00015	0.00008±0.00001
Grommet	2.435±0.012	0.944±0.013	0.271±0.005	0.02299±0.00043	0.00660±0.00015
Potting	0.047±0.004	4.628±0.098	0.173±0.004	0.00218±0.00024	0.00008±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	9.097±0.0755			0.06288±0.00182	0.00851±0.00044

TML in proportion to the total organic material mass: 0.691%±0.020%  
CVCM in proportion to the total organic material mass: 0.094%±0.005%

ND114-104S-CR (Insulator: white/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.007±0.033	0.550±0.006	0.014±0.003	0.02754±0.00048	0.0007±0.00016
R insulator	4.907±0.027	0.550±0.006	0.014±0.003	0.02699±0.00044	0.0007±0.00015
Grommet adhesive	0.022±0.003	1.669±0.003	0.658±0.011	0.00037±0.00005	0.0001±0.00002
Potting	0.490±0.015	0.570±0.059	0.163±0.006	0.00279±0.00038	0.0008±0.00005
Insert adhesive	0.017±0.002	5.461±0.059	0.483±0.006	0.00093±0.00012	0.0001±0.00001
Grommet	2.465±0.008	0.944±0.013	0.271±0.005	0.02327±0.00040	0.0067±0.00015
Potting	0.056±0.004	4.628±0.098	0.173±0.004	0.00259±0.00024	0.0001±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.0000±0.00000
Total	12.965±0.092			0.08467±0.00213	0.00919±0.00055

TML in proportion to the total organic material mass: 0.653%±0.016%  
CVCM in proportion to the total organic material mass: 0.071%±0.004%

ND114-104P-AB(1) (Insulator: white/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.322±0.007	0.550±0.006	0.014±0.003	0.0073±0.00012	0.0002±0.00004
R insulator	4.790±0.032	0.550±0.006	0.014±0.003	0.0263±0.00047	0.0007±0.00015
Potting	0.097±0.015	0.570±0.059	0.163±0.006	0.0006±0.00015	0.0002±0.00003
Insert adhesive	0.017±0.002	5.461±0.059	0.483±0.006	0.0009±0.00012	0.0001±0.00001
Potting	0.150±0.004	4.628±0.098	0.173±0.004	0.0069±0.00034	0.0003±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.0002±0.00001	0.0000±0.00000
Total	6.377±0.060			0.04223±0.00120	0.00136±0.00025

TML in proportion to the total organic material mass: 0.662%±0.019%  
CVCM in proportion to the total organic material mass: 0.021%±0.004%

ND114-104S- AB(1) (Insulator: white/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.007±0.033	0.550±0.006	0.014±0.003	0.02754±0.00048	0.0007±0.00016
R insulator	4.907±0.019	0.550±0.006	0.014±0.003	0.02699±0.00040	0.0007±0.00015
Potting	0.090±0.015	0.570±0.059	0.163±0.006	0.00051±0.00037	0.0001±0.00009
Insert adhesive	0.017±0.002	5.461±0.059	0.483±0.006	0.00093±0.00012	0.0001±0.00001
Potting	0.142±0.004	4.628±0.098	0.173±0.004	0.00657±0.00033	0.0002±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.0000±0.00000
Total	10.164±0.109			0.06273±0.00171	0.00186±0.00042

TML in proportion to the total organic material mass: 0.617%±0.017%  
CVCM in proportion to the total organic material mass: 0.018%±0.004%

JAXA-ADS-2060/D114F 21 August 2025		J A X A Application Data Sheet		Page	– 36 –
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JAHL-3300

ND114-104P-CR (Insulator: black B/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.321±0.008	0.538±0.005	0.015±0.001	0.00711±0.00011	0.00019±0.00001
R insulator	4.792±0.012	0.550±0.006	0.014±0.003	0.02578±0.00030	0.00072±0.00005
Grommet adhesive	0.020±0.003	1.669±0.003	0.658±0.011	0.00033±0.00005	0.00013±0.00002
Potting	0.465±0.015	0.570±0.059	0.163±0.006	0.00265±0.00037	0.00076±0.00005
Insert adhesive	0.017±0.0025	5.461±0.059	0.483±0.006	0.00093±0.00015	0.00008±0.00001
Grommet	2.435±0.012	0.944±0.013	0.271±0.005	0.02299±0.00043	0.00660±0.00015
Potting	0.047±0.004	4.628±0.098	0.173±0.004	0.00218±0.00024	0.00008±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	9.097±0.0565			0.06215±0.00165	0.00857±0.00032

TML in proportion to the total organic material mass: 0.683%±0.018%  
CVCM in proportion to the total organic material mass: 0.094%±0.003%

ND114-104S-CR (Insulator: black B/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.001±0.023	0.550±0.006	0.014±0.003	0.02691±0.00037	0.00075±0.00005
R insulator	4.913±0.022	0.550±0.006	0.014±0.003	0.02643±0.00037	0.00074±0.00005
Grommet adhesive	0.022±0.003	1.669±0.003	0.658±0.011	0.00037±0.00005	0.0001±0.00002
Potting	0.490±0.015	0.570±0.059	0.163±0.006	0.00279±0.00038	0.0008±0.00005
Insert adhesive	0.017±0.002	5.461±0.059	0.483±0.006	0.00093±0.00012	0.0001±0.00001
Grommet	2.465±0.008	0.944±0.013	0.271±0.005	0.02327±0.00040	0.0067±0.00015
Potting	0.056±0.004	4.628±0.098	0.173±0.004	0.00259±0.00024	0.0001±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.0000±0.00000
Total	12.965±0.077			0.08348±0.00194	0.00929±0.00035

TML in proportion to the total organic material mass: 0.644%±0.015%  
CVCM in proportion to the total organic material mass: 0.072%±0.003%

ND114-104P-AB(1) (Insulator: black B/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.321±0.008	0.550±0.006	0.014±0.003	0.00711±0.00011	0.0002±0.00001
R insulator	4.785±0.026	0.550±0.006	0.014±0.003	0.02574±0.00047	0.00072±0.00005
Potting	0.097±0.015	0.570±0.059	0.163±0.006	0.0006±0.00015	0.0002±0.00003
Insert adhesive	0.017±0.002	5.461±0.059	0.483±0.006	0.0009±0.00012	0.0001±0.00001
Potting	0.150±0.004	4.628±0.098	0.173±0.004	0.0069±0.00034	0.0003±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.0002±0.00001	0.0000±0.00000
Total	6.377±0.055			0.04146±0.00110	0.00142±0.00012

TML in proportion to the total organic material mass: 0.644%±0.015%  
CVCM in proportion to the total organic material mass: 0.072%±0.003%

ND114-104S- AB(1) (Insulator: black B/Curing agent for adhesive: 15 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.001±0.023	0.550±0.006	0.014±0.003	0.02691±0.00037	0.00075±0.00005
R insulator	4.900±0.020	0.550±0.006	0.014±0.003	0.02636±0.00040	0.00074±0.00005
Potting	0.090±0.015	0.570±0.059	0.163±0.006	0.00051±0.00037	0.0001±0.00009
Insert adhesive	0.017±0.002	5.461±0.059	0.483±0.006	0.00093±0.00012	0.0001±0.00001
Potting	0.142±0.004	4.628±0.098	0.173±0.004	0.00657±0.00033	0.0002±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.0000±0.00000
Total	10.164±0.100			0.06147±0.00156	0.00196±0.00022

TML in proportion to the total organic material mass: 0.606%±0.015%  
CVCM in proportion to the total organic material mass: 0.019%±0.002%

JAXA-ADS-2060/D114F 21 August 2025		J A X A Application Data Sheet		Page	- 37 -
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J AHL-3300

ND114-104P-CR (Insulator: black B/Curing agent for adhesive: 15-1 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.321±0.008	0.538±0.005	0.015±0.001	0.00711±0.00011	0.00020±0.00001
R insulator	4.792±0.012	0.538±0.005	0.015±0.001	0.02578±0.00030	0.00072±0.00005
Grommet adhesive	0.020±0.003	1.669±0.003	0.658±0.011	0.00033±0.00005	0.00013±0.00002
Potting	0.465±0.015	0.570±0.059	0.163±0.006	0.00265±0.00037	0.00076±0.00005
Insert adhesive	0.017±0.003	3.392±0.054	0.035±0.001	0.00058±0.00010	0.00001±0.00000
Grommet	2.435±0.012	0.944±0.013	0.271±0.005	0.02299±0.00043	0.00660±0.00015
Potting	0.047±0.004	4.628±0.098	0.173±0.004	0.00218±0.00024	0.00008±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	9.097±0.057			0.06180 ±0.00160	0.00849±0.00030

TML in proportion to the total organic material mass: 0.679%±0.018%  
CVCM in proportion to the total organic material mass: 0.093%±0.003%

ND114-104S-CR (Insulator: black B/Curing agent for adhesive: 15-1 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.001±0.023	0.538±0.005	0.015±0.001	0.02691±0.00037	0.00075±0.00005
R insulator	4.913±0.022	0.538±0.005	0.015±0.001	0.02643±0.00037	0.00074±0.00005
Grommet adhesive	0.022±0.003	1.669±0.003	0.658±0.011	0.00037±0.00005	0.0001 ±0.00002
Potting	0.490±0.015	0.570±0.059	0.163±0.006	0.00279±0.00038	0.00080±0.00005
Insert adhesive	0.017±0.002	3.392±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Grommet	2.465±0.008	0.944±0.013	0.271±0.005	0.02327±0.00040	0.00668±0.00015
Potting	0.056±0.004	4.628±0.098	0.173±0.004	0.00259±0.00024	0.00010±0.00001
Marking ink	0.001±	18.86±0.608	0.082±0.001	0.00019±0.00001	0.0000 ±0.00000
Total	12.965±0.062			0.08312±0.00190	0.00921±0.00034

TML in proportion to the total organic material mass: 0.641%±0.015%  
CVCM in proportion to the total organic material mass: 0.071%±0.003%

ND114-104P-AB(1) (Insulator: black B/Curing agent for adhesive: 15-1 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.321±0.008	0.538±0.005	0.015±0.001	0.00711±0.00011	0.00020±0.00001
R insulator	4.785±0.026	0.538±0.005	0.015±0.001	0.02574±0.00038	0.00072±0.00005
Potting	0.097±0.015	0.570±0.059	0.163±0.006	0.00055±0.00015	0.00016±0.00003
Insert adhesive	0.017±0.002	3.392±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Potting	0.150±0.004	4.628±0.098	0.173±0.004	0.00694±0.00034	0.00026±0.00001
Marking ink	0.001±	18.86±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	6.371±0.055			0.04111±0.00106	0.00134±0.00011

TML in proportion to the total organic material mass: 0.645%±0.017%  
CVCM in proportion to the total organic material mass: 0.021%±0.002%

ND114-104S- AB(1) (Insulator: black B/Curing agent for adhesive: 15-1 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.001±0.023	0.538 ±0.005	0.015±0.001	0.02691±0.00037	0.00075±0.00005
R insulator	4.900± 0.02	0.538 ±0.005	0.015±0.001	0.02636±0.00035	0.00074±0.00005
Potting	0.090±0.051	0.570 ±0.059	0.163±0.006	0.00051±0.00037	0.00015±0.00009
Insert adhesive	0.017±0.002	3.392 ±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Potting	0.142±0.004	4.628 ±0.098	0.173±0.004	0.00657±0.00033	0.00025±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	10.151±0.085			0.06112±0.00151	0.00188±0.00021

TML in proportion to the total organic material mass: 0.602%±0.015%  
CVCM in proportion to the total organic material mass: 0.019%±0.002%

ND114-104P-CR (Insulator: black BS/Curing agent: 15-1 CLEARJ)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.250 ± 0.017	0.500 ± 0.005	0.001 ± 0.000	0.00625 ± 0.00015	0.00001 ± 0.00000

JAXA-ADS-2060/D114F 21 August 2025		J A X A Application Data Sheet		Page	– 38 –
JAHL-3300					
R insulator	4.597 ± 0.010	0.500 ± 0.005	0.001 ± 0.000	0.02299 ± 0.00028	0.00005 ± 0.00000
Grommet adhesive	0.020 ± 0.003	1.669 ± 0.003	0.658 ± 0.011	0.00033 ± 0.00005	0.00013 ± 0.00002
Potting	0.465 ± 0.015	0.745 ± 0.004	0.000 ± 0.000	0.00346 ± 0.00013	0.00000 ± 0.00000
Insert adhesive	0.017 ± 0.003	3.392 ± 0.054	0.035 ± 0.001	0.00058 ± 0.00010	0.00001 ± 0.00000
Grommet	2.435 ± 0.012	0.944 ± 0.013	0.271 ± 0.005	0.02299 ± 0.00043	0.00660 ± 0.00015
Potting	0.047 ± 0.004	4.628 ± 0.098	0.173 ± 0.004	0.00218 ± 0.00024	0.00008 ± 0.00001
Marking ink	0.001 ±	18.859 ± 0.608	0.082 ± 0.001	0.00019 ± 0.00001	0.00000 ± 0.00000
Total	8.832 ± 0.064			0.05896 ± 0.00138	0.00688 ± 0.00019
TML in proportion to the total organic material mass: 0.668% ± 0.016% CVCM in proportion to the total organic material mass: 0.078% ± 0.002%					
ND114-104S-CR (Insulator: black BS/Curing agent: 15-1 CLEARJ)					
Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	4.953 ± 0.013	0.500 ± 0.005	0.001 ± 0.000	0.02477 ± 0.00031	0.00005 ± 0.00000
R insulator	4.885 ± 0.037	0.500 ± 0.005	0.001 ± 0.000	0.02443 ± 0.00043	0.00005 ± 0.00000
Grommet adhesive	0.022 ± 0.003	1.669 ± 0.003	0.658 ± 0.011	0.00037 ± 0.00005	0.0001 ± 0.00002
Potting	0.490 ± 0.015	0.745 ± 0.004	0.000 ± 0.000	0.00365 ± 0.00013	0.00000 ± 0.00000
Insert adhesive	0.017 ± 0.002	3.392 ± 0.054	0.035 ± 0.001	0.00058 ± 0.00008	0.00001 ± 0.00000
Grommet	2.465 ± 0.008	0.944 ± 0.013	0.271 ± 0.005	0.02327 ± 0.00040	0.00668 ± 0.00015
Potting	0.056 ± 0.004	4.628 ± 0.098	0.173 ± 0.004	0.00259 ± 0.00024	0.00010 ± 0.00001
Marking ink	0.001 ±	18.859 ± 0.608	0.082 ± 0.001	0.00019 ± 0.00001	0.00000 ± 0.00000
Total	12.889 ± 0.082			0.07983 ± 0.00165	0.00703 ± 0.00018
TML in proportion to the total organic material mass: 0.619% ± 0.013% CVCM in proportion to the total organic material mass: 0.055% ± 0.001%					
ND114-104P-AB(1) (Insulator: black BS/Curing agent: 15-1 CLEARJ)					
Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.250 ± 0.017	0.538 ± 0.005	0.015 ± 0.001	0.00673 ± 0.00015	0.00019 ± 0.00002
R insulator	4.597 ± 0.010	0.538 ± 0.005	0.015 ± 0.001	0.02473 ± 0.00028	0.00069 ± 0.00005
Potting	0.097 ± 0.015	0.745 ± 0.004	0.000 ± 0.000	0.00072 ± 0.00012	0.00000 ± 0.00000
Insert adhesive	0.017 ± 0.002	3.392 ± 0.054	0.035 ± 0.001	0.00058 ± 0.00008	0.00001 ± 0.00000
Potting	0.150 ± 0.004	4.628 ± 0.098	0.173 ± 0.004	0.00694 ± 0.00034	0.00026 ± 0.00001
Marking ink	0.001 ±	18.859 ± 0.608	0.082 ± 0.001	0.00019 ± 0.00001	0.00000 ± 0.00000
Total	6.112 ± 0.048			0.03989 ± 0.00098	0.00114 ± 0.00008
TML in proportion to the total organic material mass: 0.653% ± 0.016% CVCM in proportion to the total organic material mass: 0.019% ± 0.001%					
ND114-104S- AB(1) (Insulator: black BS/Curing agent: 15-1 CLEARJ)					
Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	4.953 ± 0.013	0.538 ± 0.005	0.015 ± 0.001	0.02665 ± 0.00032	0.00074 ± 0.00005
R insulator	4.885 ± 0.037	0.538 ± 0.005	0.015 ± 0.001	0.02628 ± 0.00045	0.00073 ± 0.00005
Potting	0.090 ± 0.051	0.745 ± 0.004	0.000 ± 0.000	0.00067 ± 0.00039	0.00000 ± 0.00000
Insert adhesive	0.017 ± 0.002	3.392 ± 0.054	0.035 ± 0.001	0.00058 ± 0.00008	0.00001 ± 0.00000
Potting	0.142 ± 0.004	4.628 ± 0.098	0.173 ± 0.004	0.00657 ± 0.00033	0.00025 ± 0.00001
Marking ink	0.001 ±	18.859 ± 0.608	0.082 ± 0.001	0.00019 ± 0.00001	0.00000 ± 0.00000
Total	10.088 ± 0.107			0.06094 ± 0.00156	0.00173 ± 0.00012
TML in proportion to the total organic material mass: 0.604% ± 0.015% CVCM in proportion to the total organic material mass: 0.017% ± 0.001%					

JAHL-3300

## ND114-104P-CR (Insulator: black B/Press pin adhesive and potting: TB2234H)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.321±0.008	0.538±0.005	0.015±0.001	0.00711±0.00011	0.00020±0.00001
R insulator	4.792±0.012	0.538±0.005	0.015±0.001	0.02578±0.00030	0.00072±0.00005
Grommet adhesive	0.020±0.003	1.669±0.003	0.658±0.011	0.00033±0.00005	0.00013±0.00002
Potting	0.465±0.015	0.745±0.004	0.000±0.000	0.00346±0.00013	0.00000±0.00000
Insert adhesive	0.017±0.003	3.392±0.054	0.035±0.001	0.00058±0.00010	0.00001±0.00000
Grommet	2.435±0.012	0.944±0.013	0.271±0.005	0.02299±0.00043	0.00660±0.00015
Potting	0.047±0.004	4.628±0.098	0.173±0.004	0.00218±0.00024	0.00008±0.00001
Marking ink	0.001±	18.86±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	9.098±0.057			0.06261±0.00136	0.00774±0.00025

TML in proportion to the total organic material mass: 0.688%±0.015%  
CVCM in proportion to the total organic material mass: 0.085%±0.003%

## ND114-104S-CR (Insulator: black B/Press pin adhesive and potting: TB2234H)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.001±0.023	0.538±0.005	0.015±0.001	0.02691±0.00037	0.00075±0.00005
R insulator	4.913±0.022	0.538±0.005	0.015±0.001	0.02643±0.00037	0.00074±0.00005
Grommet adhesive	0.022±0.003	1.669±0.003	0.658±0.011	0.00037±0.00005	0.0001 ±0.00002
Potting	0.490±0.015	0.745±0.004	0.000±0.000	0.00365±0.00013	0.00000±0.00000
Insert adhesive	0.017±0.002	3.392±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Grommet	2.465±0.008	0.944±0.013	0.271±0.005	0.02327±0.00040	0.00668±0.00015
Potting	0.056±0.004	4.628±0.098	0.173±0.004	0.00259±0.00024	0.00010±0.00001
Marking ink	0.001±	18.86±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	12.97±0.077			0.08398±0.00165	0.00842±0.00028

TML in proportion to the total organic material mass: 0.648%±0.013%  
CVCM in proportion to the total organic material mass: 0.065%±0.002%

## ND114-104P-AB(1) (Insulator: black B/Press pin adhesive and potting: TB2234H)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.321±0.008	0.538±0.005	0.015±0.001	0.00711±0.00011	0.00020±0.00001
R insulator	4.785±0.026	0.538±0.005	0.015±0.001	0.02574±0.00038	0.00072±0.00005
Potting	0.097±0.015	0.745±0.004	0.000±0.000	0.00072±0.00012	0.00000±0.00000
Insert adhesive	0.017±0.002	3.392±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Potting	0.150±0.004	4.628±0.098	0.173±0.004	0.00694±0.00034	0.00026±0.00001
Marking ink	0.001±	18.86±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	6.371±0.055			0.04128±0.00103	0.00118±0.00008

TML in proportion to the total organic material mass: 0.648%±0.016%  
CVCM in proportion to the total organic material mass: 0.019%±0.001%

## ND114-104S- AB(1) (Insulator: black B/Press pin adhesive and potting: TB2234H)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	5.001±0.02	0.538±0.01	0.02±0	0.02691±0.00037	0.00075±0.00005
R insulator	4.900±0.02	0.538±0.01	0.02±0	0.02636±0.00035	0.00074±0.00005
Potting	0.090±0.05	0.745±0	0.000±0.000	0.00067±0.00039	0.00000±0.00000
Insert adhesive	0.017±0	3.392±0.05	0.04±0	0.00058±0.00008	0.00001±0.00000
Potting	0.142±0	4.628±0.1	0.17±0	0.00657±0.00033	0.00025±0.00001
Marking ink	0.001±	18.9±0.61	0.08±0	0.00019±0.00001	0.00000±0.00000
Total	10.151±0.1			0.06127±0.00153	0.00174±0.00012

TML in proportion to the total organic material mass: 0.604%±0.015%  
CVCM in proportion to the total organic material mass: 0.017%±0.001%

JAHL-3300

## ND114-104P-CR (Insulator: black BS/Press pin adhesive and potting: TB2270C)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.250±0.017	0.500±0.005	0.001±0.000	0.00625±0.00015	0.00001±0.00000
R insulator	4.597±0.010	0.500±0.005	0.001±0.000	0.02299±0.00028	0.00005±0.00000
Grommet adhesive	0.020±0.003	1.669±0.003	0.658±0.011	0.00033±0.00005	0.00013±0.00002
Potting	0.585±0.019	0.541±0.006	0.003±0.000	0.00316±0.00014	0.00002±0.00000
Insert adhesive	0.017±0.003	3.392±0.054	0.035±0.001	0.00058±0.00010	0.00001±0.00000
Grommet	2.435±0.012	0.944±0.013	0.271±0.005	0.02299±0.00043	0.00660±0.00015
Potting	0.047±0.004	4.628±0.098	0.173±0.004	0.00218±0.00024	0.00008±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	8.952±0.068			0.05866±0.00139	0.00689±0.00019

TML in proportion to the total organic material mass: 0.655%±0.015%  
CVCM in proportion to the total organic material mass: 0.077%±0.002%

## ND114-104S-CR (Insulator: black BS/Press pin adhesive and potting: TB2270C)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	4.953±0.013	0.500±0.005	0.001±0.000	0.02477±0.00031	0.00005±0.00000
R insulator	4.885±0.037	0.500±0.005	0.001±0.000	0.02443±0.00043	0.00005±0.00000
Grommet adhesive	0.022±0.003	1.669±0.003	0.658±0.011	0.00037±0.00005	0.0001±0.00002
Potting	0.617±0.019	0.541±0.006	0.003±0.000	0.00334±0.00014	0.00002±0.00000
Insert adhesive	0.017±0.002	3.392±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Grommet	2.465±0.008	0.944±0.013	0.271±0.005	0.02327±0.00040	0.00668±0.00015
Potting	0.056±0.004	4.628±0.098	0.173±0.004	0.00259±0.00024	0.00010±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	13.016±0.086			0.07952±0.00166	0.00705±0.00018

TML in proportion to the total organic material mass: 0.611%±0.013%  
CVCM in proportion to the total organic material mass: 0.054%±0.001%

## ND114-104P-AB(1) (Insulator: black BS/Press pin adhesive and potting: TB2270C)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	1.250±0.017	0.538±0.005	0.015±0.001	0.00673±0.00015	0.00019±0.00002
R insulator	4.597±0.010	0.538±0.005	0.015±0.001	0.02473±0.00028	0.00069±0.00005
Potting	0.122±0.019	0.541±0.006	0.003±0.000	0.00066±0.00011	0.00000±0.00000
Insert adhesive	0.017±0.002	3.392±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Potting	0.150±0.004	4.628±0.098	0.173±0.004	0.00694±0.00034	0.00026±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	6.137±0.052			0.03982±0.00097	0.00115±0.00008

TML in proportion to the total organic material mass: 0.649%±0.016%  
CVCM in proportion to the total organic material mass: 0.019%±0.001%

## ND114-104S- AB(1) (Insulator: black BS/Press pin adhesive and potting: TB2270C)

Part name	Material mass (g)	TML (%)	CVCM (%)	TML (g)	CVCM (g)
F insulator	4.953±0.013	0.538±0.005	0.015±0.001	0.02665±0.00032	0.00074±0.00005
R insulator	4.885±0.037	0.538±0.005	0.015±0.001	0.02628±0.00045	0.00073±0.00005
Potting	0.113±0.019	0.541±0.006	0.003±0.000	0.00061±0.00011	0.00000±0.00000
Insert adhesive	0.017±0.002	3.392±0.054	0.035±0.001	0.00058±0.00008	0.00001±0.00000
Potting	0.142±0.004	4.628±0.098	0.173±0.004	0.00657±0.00033	0.00025±0.00001
Marking ink	0.001±	18.859±0.608	0.082±0.001	0.00019±0.00001	0.00000±0.00000
Total	10.11±0.075			0.06088±0.00129	0.00173±0.00012

TML in proportion to the total organic material mass: 0.602%±0.013%  
CVCM in proportion to the total organic material mass: 0.017%±0.001%

JAXA-ADS-2060/D114F 21 August 2025	J A X A Application Data Sheet	Page	– 41 –
JAHL-3300			
5.11 Residual Magnetization			
<p>Metal materials (copper alloy and aluminum alloy) and surface finishes (gold plated over copper and gold plating over nickel) used for the connectors are all nonmagnetic. Residual magnetization measured after the connector passed in the magnetic field of 0.5T {5000G} was 200nT {200γ} or less.</p>			
5.12 Fluid Immersion			
<p>The connector was soaked to the following fluids as specified in appendix D of JAXA-QTS-2060. Though swelling was observed on the silicon potting when soaked in the hydraulic fluid, the test results met all requirements.</p>			
<p>(1) Hydraulic fluid specified in MIL-PRF-5606 (2) Lubricating oil specified in MIL-PRF-23699</p>			
5.13 Resistance to Solvent			
<p>The test was performed in accordance with test method 215 of MIL-STD-202 for the marking ink, which is used for marking the part number and other information, against the following solvents which are generally used in the wiring and assembly processes. As a result, there was no degradation in legibility or color fading of the marking.</p>			
<p>(1) IPA (2) Acetone (3) Ethanol</p>			
<p>The insulators are made of diallyl phthalate resins and polytetrafluoroethylene and have sufficient resistance to the solvents.</p>			
5.14 Radiation Hardness			
<p>The test was performed in accordance with appendix D of JAXA-QTS-2060 under the following conditions. The result met all requirements.</p>			
<p>(1) Radiation type: <math>^{60}\text{Co}</math> γ-ray (2) Total dose of irradiation: <math>10^5\text{Gy}</math> {<math>10^7\text{rad}</math>}</p>			
6. STORAGE CONDITIONS			
<p>(1) The connectors are ultrasonic cleaned and sealed before shipping. Do not open the sealed bag if not necessary. Re-seal the bag before storage if opened for receiving inspection or other needs. (2) To store unmated connectors, attach the dust caps to protect the connectors from dusts and/or external forces. (3) Store the connectors at an ambient temperature and humidity if possible. (4) Minimize vibrations and shocks during shipping and storage.</p>			



## 7. OTHERS

## 7.1 Mass

The mass values of D-sub connectors and contacts are as follows:

## (1) Connector

**Table 12. Mass of Connector (1 pc.)**

Termination type	Part number	Mass (g)±10% <sup>(1)</sup>
Crimp	ND114-104P-CR	24.59
	ND114-104S-CR	31.36
Right angle through hole	ND114-104P-AB(1)	26.10
	ND114-104S-AB(1)	34.05

Note: <sup>(1)</sup> The mass includes the mass of contact.

## (2) Individual contact

**Table 13. Mass of Individual Contact (1 pc.)**

Termination type	Part number	Mass (g)±10%
Crimp	ND104-P-C22D	0.078
	ND104-S-C22D	0.105

## 7.2 Accessories

Table 14 shows accessories certified by JAXA for space use D-sub rectangular connectors. These accessories are designed for space applications and meet the non-magnetic, non-sublimation and outgassing requirements.

Contact the supplies for details.

**Table 14. Accessories for Connectors**

Item		Part number	Remark
Screw lock	Female	ND102-SL-F	Certified parts
	Male	ND102-SL-M5	

## 7.3 Cables

JAXA certified cables or space-use MIL standard polyimide cable (high strength silver-coated copper alloy cable per MIL-W-81381) shall be used in the qualification test. The specifications are given in Table 15.

**Table 15. Cable Specifications**

Insulation resistance (min.): 762MΩ·km (2,500MΩ·1,000ft)

Item	Conductor				External diameter of insulator		Resistance at 20°C, Ω/1,000ft (Ω/km) max.
	AWG	Stranding No. of strands x AWG (no. of strands/mm)	External diameter		Inch (mm) min.	Inch (mm) max.	
			Inch (mm) min.	Inch (mm) max.			
M81381/ 10-28	28	7 x 36 (7/0.127)	.014 (0.356)	.016 (0.406)	.026 (0.660)	.030 (0.762)	79.0 (259)
M81381/ 10-26	26	19 x 38 (7/0.102)	.018 (0.457)	.020 (0.508)	.031 (0.787)	.034 (0.864)	49.4 (162)

#### 7.4 Contact Information

- (1) Manufacturer: Japan Aviation Electronics Industry, Ltd.
- (2) Address: 1-19, Aobadai 3-chome, Meguro-ku, Tokyo 153-0042, Japan
- (3) Tel: +81-3-3780-2865 (Connector 1st Sales Div.)